

ZL50020 Enhanced 2 K Digital Switch

Data Sheet

Features November 2006

- 2048 channel x 2048 channel non-blocking digital Time Division Multiplex (TDM) switch at 8.192 Mbps and 16.384 Mbps or using a combination of ports running at 2.048, 4.096, 8.192 and 16.384 Mbps
- 32 serial TDM input, 32 serial TDM output streams
- Output streams can be configured as bidirectional for connection to backplanes
- Exceptional input clock cycle to cycle variation tolerance (20 ns for all rates)
- Per-stream input and output data rate conversion selection at 2.048, 4.096, 8.192 or 16.384 Mbps. Input and output data rates can differ
- Per-stream high impedance control outputs (STOHZ) for 16 output streams
- Per-stream input bit delay with flexible sampling point selection
- Per-stream output bit and fractional bit advancement

- **Ordering Information** ZL50020GAC 256 Ball PBGA 256 Lead LQFP Trays ZL50020QCC Trays ZL50020QCG1 256 Lead LQFP* Trays, Bake & Drypack ZL50020GAG2 256 Ball PBGA** Trays, Bake & Drypack *Pb Free Matte Tin **Pb Free Tin/Silver/Copper -40°C to +85°C
- Per-channel ITU-T G.711 PCM A-Law/μ-Law Translation
- Four frame pulse and four reference clock outputs
- Three programmable delayed frame pulse outputs
- Input clock: 4.096 MHz, 8.192 MHz, 16.384 MHz
- Input frame pulses:61 ns, 122 ns, 244 ns
- Per-channel constant or variable throughput delay for frame integrity and low latency applications
- Per Stream (32) Bit Error Rate Test circuits complying to ITU-0.151

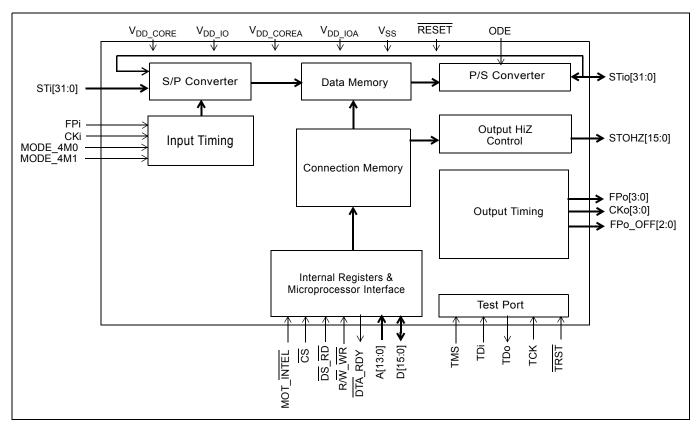


Figure 1 - ZL50020 Functional Block Diagram

- · Per-channel high impedance output control
- · Per-channel message mode
- · Control interface compatible with Intel and Motorola 16-bit non-multiplexed buses
- · Connection memory block programming
- Supports ST-BUS and GCI-Bus standards for input and output timing
- IEEE-1149.1 (JTAG) test port
- 3.3 V I/O with 5 V tolerant inputs; 1.8 V core voltage

Applications

- · PBX and IP-PBX
- · Small and medium digital switching platforms
- · Remote access servers and concentrators
- Wireless base stations and controllers
- Multi service access platforms
- · Digital Loop Carriers
- Computer Telephony Integration

Description

The ZL50020 is a maximum 2048 x 2048 channel non-blocking digital Time Division Multiplex (TDM) switch. It has thirty-two input streams (STi0 - 31) and thirty-two output streams (STi00 - 31). The device can switch 64 kbps and Nx64 kbps TDM channels from any input stream to any output stream. Each of the input and output streams can be independently programmed to operate at any of the following data rates: 2.048 Mbps, 4.096 Mbps, 8.192 Mbps or 16.384 Mbps. The ZL50020 provides up to sixteen high impedance control outputs (STOHZ0 - 15) to support the use of external tristate drivers for the first sixteen output streams (STi00 - 15). The output streams can be configured to operate in bi-directional mode, in which case STi0 - 31 will be ignored.

The device contains two types of internal memory - data memory and connection memory. There are four modes of operation - Connection Mode, Message Mode, BER mode and high impedance mode. In Connection Mode, the contents of the connection memory define, for each output stream and channel, the source stream and channel (the actual data to be output is stored in the data memory). In Message Mode, the connection memory is used for the storage of microprocessor data. Using Zarlink's Message Mode capability, microprocessor data can be broadcast to the data output streams on a per-channel basis. This feature is useful for transferring control and status information for external circuits or other TDM devices. In BER mode the output channel data is replaced with a pseudorandom bit sequence (PRBS) from one of 32 PRBS generators that generates a 2¹⁵-1 pattern. On the input side channels can be routed to one of 32 bit error detectors. In high impedance mode the selected output channel can be put into a high impedance state.

The configurable non-multiplexed microprocessor port allows users to program various device operating modes and switching configurations. Users can employ the microprocessor port to perform register read/write, connection memory read/write, and data memory read operations. The port is configurable to interface with either Motorola or Intel-type microprocessors.

The device also supports the mandatory requirements of the IEEE-1149.1 (JTAG) standard via the test port.

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Changes Summary

The following table captures the changes from January 2006 to November 2006.

Page	Item	Change
1		Updated Ordering Information.

The following table captures the changes from the October 2004 issue.

Page	Item	Change
13	Pin Description "CKi" on page 13	Clarified pin description for CKi.
32	11.3, "Output Clock Frequencies"	Added new section to describe output clock frequencies.

Pinout Diagrams 1.0

1.1 **BGA Pinout**

`	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	
Α	V _{SS}	STi29	STi28	STi27	STi25	STi26	STi24	NC	NC	STio22	STio23	STio21	STio20	NC	NC	V _{SS}	Α
В	STi31	STi10	STi5	STi4	CKo2	STi0	CKo0	NC	V _{DD} _ COREA	FPi	CKi	IC_Open	IC_Open	IC_GND	ODE	STio19	В
С	STi30	STi9	V _{SS}	STi7	STi6	STi1	CKo1	NC	V _{SS}	IC_Open	IC_Open	IC_Open	IC_GND	V _{SS}	STio15	STio18	С
D	STi17	STi11	V _{DD_IO}	STi3	STi2	NC	NC	NC	NC	V _{SS}	FPo_ OFF1	IC_GND	STio13	V _{DD_IO}	STio14	STio16	D
Е	STi16	STi14	STi8	V _{DD_IO}	V _{SS}	V _{DD} _ CORE	NC	NC	NC	NC	V _{DD} _ CORE	V _{SS}	V _{DD_IO}	STio12	FPo2	STio17	Е
F	STi19	STi15	STi12	STi13	V _{DD_IO}	V _{DD} _ CORE	V _{DD} _ CORE	V _{SS}	V _{SS}	V _{DD} _ CORE	V _{DD} _ CORE	V _{DD_IO}	IC	FPo3	FPo_ OFF2	STOHZ15	F
G	STi18	RESET	IC_GND	IC_Open	TDo	V _{DD_IO}	V_{SS}	V _{SS}	V _{SS}	V _{SS}	V _{DD_IO}	A12	A13	FPo1	FPo0	STOHZ14	G
Н	STi21	V _{SS}	V _{SS}	V _{DD} _ COREA	NC	V _{SS}	V _{SS}	V _{SS}	V _{SS}	V _{SS}	A7	A9	A10	FPo_ OFF0	A11	STOHZ12	н
J	STi20	V _{DD_IOA}	V _{DD_IOA}	V _{SS}	V _{SS}	CKo3	V_{SS}	V _{SS}	V _{SS}	V _{SS}	A3	A4	A5	A8	A6	STOHZ13	J
K	STi22	V _{SS}	TMS	V _{SS}	V _{DD} _ COREA	V _{DD_IO}	V_{SS}	V _{SS}	V _{SS}	V _{SS}	V _{DD_IO}	IC_Open	A0	A2	A1	STOHZ11	K
L	STi23	V _{DD} _ COREA	TRST	TCK	V _{DD_IO}	V _{DD} _ CORE	V _{DD} _ CORE	V _{SS}	V _{SS}	V _{DD} _ CORE	V _{DD} _ CORE	V _{DD_IO}	STio10	STio11	STio9	STOHZ10	L
M	STio25	NC	TDi	D0	V _{SS}	V _{DD} _ CORE	V _{DD} _ CORE	D6	D10	V _{DD} _ CORE	V _{DD} _ CORE	V _{SS}	MOT_ INTEL	MODE_ 4M0	STio8	STOHZ9	М
N	STio24	NC	V _{DD_IO}	STio0	STOHZ3	D1	D5	D7	D11	D13	R/W _WR	DTA_ RDY	STio4	V _{DD_IO}	STOHZ5	STOHZ8	N
Р	STio26	NC	V _{SS}	STio1	STio3	STOHZ1	D3	D8	D14	NC	STio5	STOHZ4	STOHZ6	V _{SS}	STOHZ7	NC	Р
R	STio27	NC	STOHZ0	STio2	STOHZ2	D2	D4	D9	D12	D15	CS	DS_RD	MODE_ 4M1	STio6	STio7	NC	R
Т	V _{SS}	STio28	STio29	STio31	STio30	NC	NC	NC	NC	NC	NC	NC	NC	NC	NC	V _{SS}	Т
	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	•

Note: A1 corner identified by metallized marking. **Note:** Pinout is shown as viewed through top of package.

Figure 2 - ZL50020 256-Ball 17 mm x 17 mm PBGA (as viewed through top of package)

1.2 QFP Pinout

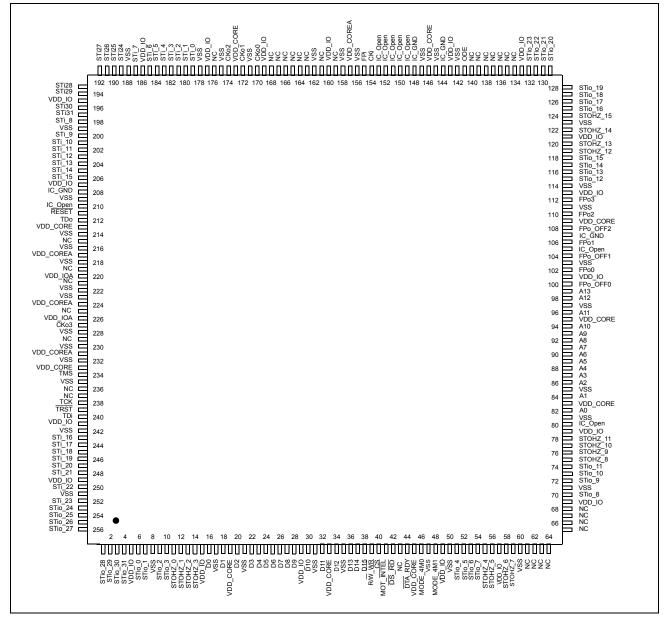


Figure 3 - ZL50020 256-Lead 28 mm x 28 mm LQFP (top view)

2.0 Pin Description

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
E6, E11, F6, F7, F10, F11, L6, L7, L10, L11, M6, M7, M10, M11	19, 33, 45, 83, 95, 109, 146, 173, 213, 233	V _{DD_CORE}	Power Supply for the core logic: +1.8 V
H4, K5, B9, L2	217, 231, 157, 224	V _{DD_COREA}	Power Supply for analog circuitry: +1.8 V
D3, D14, E4, E13, F5, F12, G6, G11, K6, K11, L5, L12, N3, N14	5, 15, 29, 49, 57, 69, 79, 101, 113, 121, 133, 143, 160, 169, 177, 186, 195, 207, 241, 249	V _{DD_IO}	Power Supply for I/O: +3.3 V
J2, J3	220, 226	V_{DD_IOA}	Power Supply for the CKo5 and CKo3 outputs: +3.3 V
A1, A16, C3, C9, C14, D10, E5, E12, F8, F9, G7, G8, G9, G10, H2, H3, H6, H7, H8, H9, H10, J4, J5, J7, J8, J9, J10, K2, K4, K7, K8, K9, K10, L8, L9, M5, M12, P3, P14, T1, T16	8, 17, 21, 31, 35, 47, 50, 60, 71, 81, 85, 97, 103, 111, 114, 123, 142, 145, 147, 156, 158, 162, 171, 175, 178, 188, 199, 209, 214, 216, 218, 222, 223, 228, 230, 232, 235, 242, 251	V _{SS}	Ground

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
К3	234	TMS	Test Mode Select (5 V-Tolerant Input with Internal Pull-up) JTAG signal that controls the state transitions of the TAP controller. This pin is pulled high by an internal pull-up resistor when it is not driven.
L4	238	TCK	Test Clock (5 V-Tolerant Schmitt-Triggered Input with Internal Pull-up) Provides the clock to the JTAG test logic.
L3	239	TRST	Test Reset (5 V-Tolerant Input with Internal Pull-up) Asynchronously initializes the JTAG TAP controller by putting it in the Test-Logic-Reset state. This pin should be pulsed low during power-up to ensure that the device is in the normal functional mode. When JTAG is not being used, this pin should be pulled low during normal operation.
M3	240	TDi	Test Serial Data In (5 V-Tolerant Input with Internal Pull-up) JTAG serial test instructions and data are shifted in on this pin. This pin is pulled high by an internal pull-up resistor when it is not driven.
G5	212	TDo	Test Serial Data Out (5 V-Tolerant Three-state Output) JTAG serial data is output on this pin on the falling edge of TCK. This pin is held in high impedance state when JTAG is not enabled.
B12, B13, C10, C11, F13, G4, K12, C12,	80, 105, 150, 151, 152, 153, 210, 149	IC_Open	Internal Test Mode (5 V-Tolerant Input with Internal Pull-down) These pins may be left unconnected.
G3, D12, B14, C13	144, 107, 148, 208	IC_GND	Internal Test Mode Enable (5 V-Tolerant Input) These pins MUST be low.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
A8, A9, A14, A15, E10, M2, N2, P2, P16, R2, R16, T6, T7, T8, T9, T10, T11, T12, T13, T14, T15, D9, E8, C8, E7, D6, H5, P10, E9, D8, B8, D7	61, 62, 63, 64, 65, 66, 67, 68, 134, 135, 136, 137, 138, 139, 140, 152, 215, 219, 225, 229, 236, 237159, 163, 165, 167, 176, 221, 43, 161, 164, 166, 168	NC	No Connect These pins MUST be left unconnected.
M14, R13	46, 48	MODE_4M0, MODE_4M1	4M Input Clock Mode 0 to 1 (5 V-Tolerant Input with internal pull-down) These two pins should be tied together and are typically used to select CKi = 4.096 MHz operation. See Table 7, "ZL50020 Operating Modes" on page 32 for a detailed explanation. See Table 13, "Control Register (CR) Bits" on page 39 for CKi and FPi selection using the CKIN1 - 0 bits.
G15, G14, E15, F14	102, 106, 110, 112	FPo0 - 3	ST-BUS/GCI-Bus Frame Pulse Outputs 0 to 3 (5 V-Tolerant Three-state Outputs) FPo0: 8 kHz frame pulse corresponding to the 4.096 MHz output clock of CKo0. FPo1: 8 kHz frame pulse corresponding to the 8.192 MHz output clock of CKo1. FPo2: 8 kHz frame pulse corresponding to 16.384 MHz output clock of CKo2. FPo3: Programmable 8 kHz frame pulse corresponding to 4.096 MHz, 8.192 MHz, 16.384 MHz, or 32.768 MHz output clock of CKo3.
H14, D11, F15	100, 104, 108	FPo_OFF0 - 2	Generated Offset Frame Pulse Outputs 0 to 2 (5 V-Tolerant Three-state Outputs) Individually programmable 8 kHz frame pulses, offset from the output frame boundary by a programmable number of channels.
B7, C7, B5, J6	170, 172, 174, 227	CKo0 - 3	ST-BUS/GCI-Bus Clock Outputs 0 to 3 (5 V-Tolerant Three-state Outputs) CKo0: 4.096 MHz output clock. CKo1: 8.192 MHz output clock. CKo2: 16.384 MHz output clock. CKo3: 4.096 MHz, 8.192 MHz or 16.384 MHz programmable output clock. 32.768 MHz if in multiplied clock mode.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
B10	155	FPi	ST-BUS/GCI-Bus Frame Pulse Input (5 V-Tolerant Schmitt-Triggered Input) This pin accepts the frame pulse which stays active for 61 ns, 122 ns or 244 ns at the frame boundary. The frame pulse frequency is 8 kHz. The frame pulse associated with the CKi must be applied to this pin. If the data rate is 16.384 Mbps, a 61 ns wide frame pulse must be used. By default, the device accepts a negative frame pulse in ST-BUS format, but it can accept a positive frame pulse instead if the FPINP bit is set high in the Control Register (CR). It can accept a GCI-formatted frame pulse by programming the FPINPOS bit in the Control Register (CR) to high.
B11	154	CKi	ST-BUS/GCI-Bus Clock Input (5 V-Tolerant Schmitt-Triggered Input) This pin accepts a 4.096 MHz, 8.192 MHz or 16.384 MHz clock. In divided clock mode the clock frequency applied to this pin must be twice the highest input or output data rate. In multiplied clock mode the clock frequency applied to this pin must be twice the highest input data rate. The exception is, when data is running at 16.384 Mbps, a 16.384 MHz clock must be used. By default, the clock falling edge defines the input frame boundary, but the device allows the clock rising edge to define the frame boundary by programming the CKINP bit in the Control Register (CR).
B6, C6, D5, D4, B4, B3, C5, C4, E3, C2, B2, D2, F3, F4, E2, F2, E1, D1, G1, F1, J1, H1, K1, L1, A7, A5, A6, A4, A3, A2, C1, B1	179, 180, 181, 182, 183, 184, 185, 187, 198, 200, 201, 202, 203, 204, 205, 206, 243, 244, 245, 246, 247, 248, 250, 252, 189, 190, 191, 192, 193, 194, 196, 197	STi0 - 31	Serial Input Streams 0 to 31 (5 V-Tolerant Inputs with Internal Pull-downs) The data rate of each input stream can be selected independently using the Stream Input Control Registers (SICR[n]). In the 2.048 Mbps mode, these pins accept serial TDM data streams at 2.048 Mbps with 32 channels per frame. In the 4.096 Mbps mode, these pins accept serial TDM data streams at 4.096 Mbps with 64 channels per frame. In the 8.192 Mbps mode, these pins accept serial TDM data streams at 8.192 Mbps with 128 channels per frame. In the 16.384 Mbps mode, these pins accept TDM data streams at 16.384 Mbps with 256 channels per frame.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
N4, P4, R4, P5, N13, P11, R14, R15, M15, L15, L13, L14, E14, D13, D15, C15, D16, E16, C16, B16, A13, A12, A10, A11, N1, M1, P1, R1, T2, T3, T5, T4	6, 7, 9, 10, 51, 52, 53, 54, 70, 72, 73, 74, 115, 116, 117, 118, 125, 126, 127, 128, 129, 130, 131, 132, 253, 254, 255, 256, 1, 2, 3, 4	STio0 - 31	Serial Output Streams 0 to 31 (5 V-Tolerant Slew-Rate-Limited Three-state I/Os with Enabled Internal Pull-downs) The data rate of each output stream can be selected independently using the Stream Output Control Registers (SOCR[n]). In the 2.048 Mbps mode, these pins output serial TDM data streams at 2.048 Mbps with 32 channels per frame. In the 4.096 Mbps mode, these pins output serial TDM data streams at 4.096 Mbps with 64 channels per frame. In the 8.192 Mbps mode, these pins output serial TDM data streams at 8.192 Mbps with 128 channels per frame. In the 16.384 Mbps mode, these pins output serial TDM data streams at 16.384 Mbps with 256 channels per frame. These output streams can be used as bi-directionals by programming BDH (bit 7) and BDL (bit 6) of Internal Mode Selection (IMS) register.
R3, P6, R5, N5, P12, N15, P13, P15, N16, M16, L16, K16, H16, J16, G16, F16	11, 12, 13, 14, 55, 56, 58, 59, 75, 76, 77, 78, 119, 120, 122, 124	STOHZ0 - 15	Serial Output Streams High Impedance Control 0 to 15 (5 V-Tolerant Slew-Rate-Limited Three-state Outputs) These pins are used to enable (or disable) external three-state buffers. When an output channel is in the high impedance state, the STOHZ drives high for the duration of the corresponding output channel. When the STio channel is active, the STOHZ drives low for the duration of the corresponding output channel. STOHZ outputs are available for STio0 - 15 only.
B15	141	ODE	Output Drive Enable (5 V-Tolerant Input with Internal Pull-up) This is the output enable control for STio0 - 31 and the output-driven-high control for STOHZ0 - 15. When it is high, STio0 - 31 and STOHZ0 - 15 are enabled. When it is low, STio0 - 31 are tristated and STOHZ0 - 15 are driven high.
M4, N6, R6, P7, R7, N7, M8, N8, P8, R8, M9, N9, R9, N10, P9, R10	16, 18, 20, 22, 23, 24, 25, 26, 27, 28, 30, 32, 34, 36, 37, 38	D0 - 15	Data Bus 0 to 15 (5 V-Tolerant Slew-Rate-Limited Three-state I/Os) These pins form the 16-bit data bus of the microprocessor port.

PBGA Pin Number	LQFP Pin Number	Pin Name	Description
N12	44	DTA_RDY	Data Transfer Acknowledgment_Ready (5 V-Tolerant Three-state Output) This active low output indicates that a data bus transfer is complete for the Motorola interface. For the Intel interface, it indicates a transfer is completed when this pin goes from low to high. An external pull-up resistor MUST hold this pin at HIGH level for the Motorola mode. An external pull-down resistor MUST hold this pin at LOW level for the Intel mode.
R11	40	CS	Chip Select (5 V-Tolerant Input) Active low input used by the Motorola or Intel microprocessor to enable the microprocessor port access.
N11	39	R/W_WR	Read/Write_Write (5 V-Tolerant Input) This input controls the direction of the data bus lines (D0 - 15) during a microprocessor access. For the Motorola interface, this pin is set high and low for the read and write access respectively. For the Intel interface, a write access is indicated when this pin goes low.
R12	42	DS_RD	Data Strobe_Read (5 V-Tolerant Input) This active low input works in conjunction with CS to enable the microprocessor port read and write operations for the Motorola interface. A read access is indicated when it goes low for the Intel interface.
K13, K15, K14, J11, J12, J13, J15, H11, J14, H12, H13, H15, G12, G13	82, 84, 86, 87, 88, 89, 90, 91, 92, 93, 94, 96, 98, 99	A0 - 13	Address 0 to 13 (5 V-Tolerant Inputs) These pins form the 14-bit address bus to the internal memories and registers.
M13	41	MOT_INTEL	Motorola_Intel (5 V-Tolerant Input with Internal Pull-up) This pin selects the Motorola or Intel microprocessor interface to be connected to the device. When this pin is unconnected or connected to high, Motorola interface is assumed. When this pin is connected to ground, Intel interface should be used.
G2	211	RESET	Device Reset (5 V-Tolerant Input with Internal Pull-up) This input (active LOW) puts the device in its reset state that disables the STio0 - 31 drivers and drives the STOHZ0 - 15 outputs to high. It also preloads registers with default values and clears all internal counters. To ensure proper reset action, the reset pin must be low for longer than 1 μs . Upon releasing the reset signal to the device, the first microprocessor access cannot take place for at least 600 μs due to the time required to stabilize the device from the power-down state. Refer to Section Section 13.2 on page 33 for details.

3.0 Device Overview

The device has thirty-two ST-BUS/GCI-Bus inputs (STi0 - 31) and thirty-two ST-BUS/GCI-Bus outputs (STi00 - 31). STi00 - 31 can also be configured as bi-directional pins, in which case STi0 - 31 will be ignored. It is a non-blocking digital switch with 2048 64 kbps channels and is capable of performing rate conversion between ST-BUS/GCI-Bus inputs and ST-BUS/GCI-Bus outputs. The ST-BUS/GCI-Bus inputs accept serial input data streams with data rates of 2.048 Mbps, 4.096 Mbps, 8.192 Mbps and 16.384 Mbps on a per-stream basis. The ST-BUS/GCI-Bus outputs deliver serial data streams with data rates of 2.048 Mbps, 4.096 Mbps and, 8.192 Mbps and 16.384 Mbps on a per-stream basis. The device also provides sixteen high impedance control outputs (STOHZ0 - 15) to support the use of external ST-BUS/GCI-Bus tristate drivers for the first sixteen ST-BUS/GCI-Bus outputs (STi00 -15).

By using Zarlink's message mode capability, microprocessor data stored in the connection memory can be broadcast to the output streams on a per-channel basis. This feature is useful for transferring control and status information for external circuits or other ST-BUS/GCI-Bus devices.

The device uses the ST-BUS/GCI-Bus input frame pulse (FPi) and the ST-BUS/GCI-Bus input clock (CKi) to define the input frame boundary and timing for sampling the ST-BUS/GCI-Bus input streams with various data rates. The output data streams will be driven by and have their timing defined by FPi and CKi in Divided Clock mode (CLKM bit 11 Table 13, Control Register (CR) Bits. In Multiplied Clock mode, the output data streams will be driven by an internally generated clock, which is multiplied from CKi internally. In Multiplied Clock mode, the output data streams will be driven by an internally generated clock, which is multiplied from CKi internally. Refer to Application Note ZLAN-120 for further explanation of the different modes of operation.

There are two clock modes for this device:

The first is the Divided Clock mode. In this mode, output streams are clocked by input CKi. Therefore the output streams have exactly the same jitter as the input streams. The output data rate can be the same as or lower than the input data rate, but the output data rate cannot be higher than what CKi can drive. For example, if CKi is 4.096 MHz, the output data rate cannot be higher than 2.048 Mbps. The second clock mode is called Multiplied Clock mode. In this mode, CKi is used to generate a 16.384 MHz clock internally, and output streams are driven by this internal clock. In Multiplied Clock mode, the data rate of output streams can be any rate, but output jitter may not be exactly the same as input jitter.

A Motorola or Intel compatible non-multiplexed microprocessor port allows users to program the device to operate in various modes under different switching configurations. Users can use the microprocessor port to perform internal register and memory read and write operations. The microprocessor port has a 16-bit data bus, a 14-bit address bus and six control signals (MOT_INTEL, CS, DS_RD, R/W_WR and DTA_RDY).

The device supports the mandatory requirements of the IEEE-1149.1 (JTAG) standard via the test port.

4.0 Data Rates and Timing

The ZL50020 has 32 serial data inputs and 32 serial data outputs. Each stream can be individually programmed to operate at 2.048 Mbps, 4.096 Mbps, 8.192 Mbps or 16.384 Mbps. Depending on the data rate there will be 32 channels, 64 channels, 128 channels or 256 channels, respectively, during a 125 μ s frame.

The output streams can be programmed to operate as bi-directional streams. The output streams are divided into two groups to be programmed into bi-directional mode. By setting BDL (bit 6) in the Internal Mode Selection (IMS) register, input streams 0 - 15 (STi0 - 15) are internally tied low, and output streams 0 - 15 (STi00 - 15) are set to operate in a bi-directional mode. Similarly, when BDH (bit 7) in the Internal Mode Selection (IMS) register is set, input streams 16 - 31 (STi16 - 31) are internally tied low, and output streams 16 - 31 (STi016 - 31) are set to operate in bi-directional mode. The groups do not have to be set into the same mode. Therefore it is possible to have half of the streams operating in bi-directional mode while the other half is operating in normal input/output mode.

The input data rate is set on a per-stream basis by programming STIN[n]DR3 - 0 (bits 3 - 0) in the Stream Input Control Register 0 - 31 (SICR0 - 31). The output data rate is set on a per-stream basis by programming STO[n]DR3 - 0 (bits 3 - 0) in the Stream Output Control Register 0 - 31 (SOCR0 - 31). The output data rates do not have to match or follow the input data rates. he maximum number of channels switched is limited to 2048 channels. If all 32

input streams were operating at 16.384 Mbps (256 channels per stream), this would result in 8192 channels. Memory limitations prevent the device from operating at this capacity. A maximum capacity of 2048 channels will occur if eight of the streams are operating at 16.384 Mbps, half of the streams are operating at 8.192 Mbps or all streams operating at 4.096 Mbps. With all streams operating at 2.048 Mbps, the capacity will be reduced to 1024 channels. However, as each stream can be programmed to a different data rate, any combination of data rates can be achieved, as long as the total channel count does not exceed 2048 channels. It should be noted that only full stream can be programmed for use. The device does not allow fractional streams. External High Impedance Control, STOHZ0 - 15.

There are 16 external high impedance control signals, STOHZ0 - 15, that are used to control the external drivers for per-channel high impedance operations. Only the first sixteen ST-BUS/GCI-Bus (STio0 - 15) outputs are provided with corresponding STOHZ signals. The STOHZ outputs deliver the appropriate number of control timeslot channels based on the output stream data rate. Each control timeslot lasts for one channel time. When the ODE pin is high and the OSB (bit 2) of the Control Register (CR) is also high, STOHZ0 - 15 are enabled. When the ODE pin, OSB (bit 2) of the Control Register (CR) or the RESET pin is low, STOHZ0 - 15 are driven high, together with all the ST-BUS/GCI-Bus outputs being tristated. Under normal operation, the corresponding STOHZ outputs of any unused ST-BUS/GCI-Bus channel (high impedance) are driven high. Refer to Figure 16 on page 28 for a diagrammatical explanation.

4.1 Input Clock (CKi) and Input Frame Pulse (FPi) Timing

The frequency of the input clock (CKi) for the ZL50020 depends on the operation mode selected. In divided clock mode, CKi must be at least twice the highest input or output data rate. For example, if the highest input data rate is 4.096 Mbps and the highest output data rate is 8.192 Mbps, the input clock, CKi, must be 16.384 MHz, which is twice the highest overall data rate. The only exception to this is for 16.384 Mbps input or output data. In this case, the input clock, CKi, is equal to the data rate. The input frame pulse, FPi, must always follow CKi. In multiplied clock mode the frequency of CKi must be at least twice the highest input data rate regardless of the output data rate. An APLL is used to multiple CKi to generate an internal clock that is used to output clocks and STio streams. Following the example above, if the highest input data rate is 4.096 Mbps, the input clock, CKi, must be 8.192 MHz, regardless of the output data rate. The only exception to this is for 16.384 Mbps input or output data. In this case, the input clock, CKi, is equal to the data rate. The input frame pulse, FPi, must always follow CKi.

In either mode the user has to program the CKIN1 - 0 (bits 6 - 5) in the Control Register (CR) to indicate the width of the input frame pulse and the frequency of the input clock supplied to the device.

Highest <i>Input or Output</i> Data Rate	CKIN 1-0 Bits	Input Clock Rate (CKi)	Input Frame Pulse (FPi)
8.192 Mbps or 16.384 Mbps	00	16.384 MHz	8 kHz (61 ns wide pulse)
4.096 Mbps	01	8.192 MHz	8 kHz (122 ns wide pulse)
2.048 Mbps	10	4.096 MHz	8 kHz (244 ns wide pulse)

Table 1 - CKi and FPi Configurations for Divided Clock Modes

Highest Input Data Rate	CKIN 1-0 Bits	Input Clock Rate (CKi)	Input Frame Pulse (FPi)
8.192 Mbps or 16.384 Mbps	00	16.384 MHz	8 kHz (61 ns wide pulse)
4.096 Mbps	01	8.192 MHz	8 kHz (122 ns wide pulse)
2.048 Mbps	10	4.096 MHz	8 kHz (244 ns wide pulse)

Table 2 - CKi and FPi Configurations for Multiplied Clock Mode

The ZL50020 accepts positive and negative ST-BUS/GCI-Bus input clock and input frame pulse formats via the programming of CKINP (bit 8) and FPINP (bit 7) in the Control Register (CR). By default, the device accepts the negative input clock format and ST-BUS format frame pulses. However, the switch can also accept a positive-going clock format by programming CKINP (bit 8) in the Control Register (CR). A GCI-Bus format frame pulse can be used by programming FPINPOS (bit 9) and FPINP (bit 7) in the Control Register (CR).

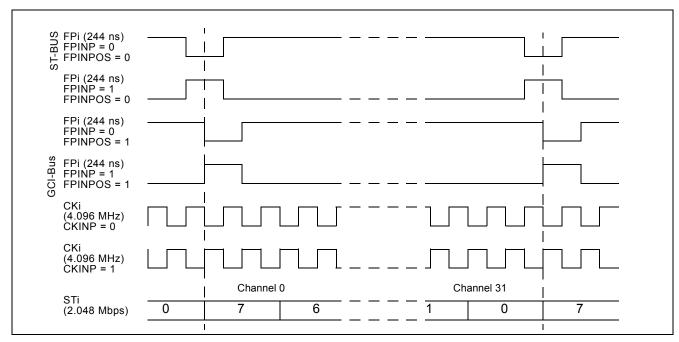


Figure 4 - Input Timing when CKIN1 - 0 bits = "10" in the CR

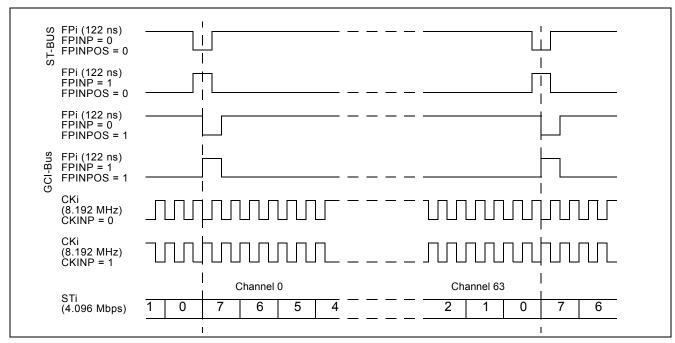


Figure 5 - Input Timing when CKIN1 - 0 bits = "01" in the CR

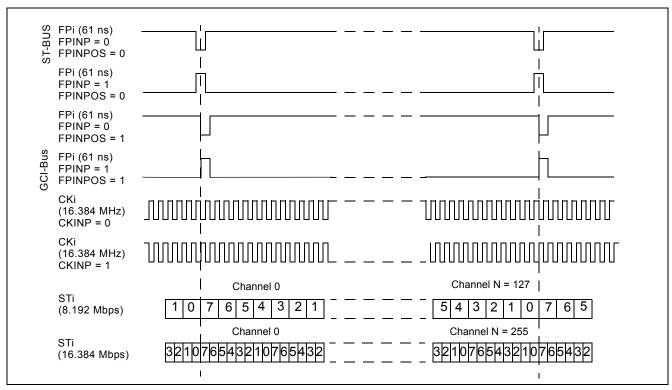


Figure 6 - Input Timing when CKIN1 - 0 = "00" in the CR

5.0 ST-BUS and GCI-Bus Timing

The ZL50020 is capable of operating using either the ST-BUS or GCI-Bus standards. The output timing that the device generates is defined by the bus standard. In the ST-BUS standard, the output frame boundary is defined by the falling edge of CKo while FPo is low. In the GCI-Bus standard, the frame boundary is defined by the rising edge of CKo while FPo goes high. The data rates define the number of channels that are available in a 125 μ s frame pulse period.

By default, the ZL50020 is configured for ST-BUS input and output timing. To set the input timing to conform to the GCI-Bus standard, FPINPOS (bit 9) and FPINP (bit 7) in the Control Register (CR) must be set. To set output timing to conform to the GCI-Bus standard, FPO[n]P and FPO[n]POS must be set in the Output Clock and Frame Pulse Selection Register (OCFSR). The CKO[n]P bits in the Output Clock and Frame Pulse Selection Register control the polarity (positive-going or negative-going) of the output clocks.

6.0 Output Timing Generation

The ZL50020 generates frame pulse and clock timing. There are four output frame pulse pins (FPo0 - 3) and four output clock pins (CKo0 - 3). All output frame pulses are 8 kHz output signals. By default, the output frame boundary is defined by the falling edge of the CKo0, while FPo0 is low. At the output frame boundary, the CKo1, CKo2 and CKo3 output clocks will by default have a falling edge, while FPo1, FPo2 and FPo3 will be low. The duration of the frame pulse low cycle and the frequency of the corresponding output clock are shown in Table 3 on page 19. Every frame pulse and clock output can be tristated by programming the enable bits in the Internal Mode Selection (IMS) register.



Table 3 - Output Timing Generation

FPo0 pulse width	244	ns
CKo0	4.096	MHz
FPo1 pulse width	122	ns
CKo1	8.192	MHz
FPo2 pulse width	61	ns
CKo2	16.384	MHz
FPo3 pulse width	244, 122, 61 or 30	ns
CKo3	4.096, 8.192, 16.384 or 32.768	MHz

Table 3 - Output Timing Generation

The output timing is dependent on the operation mode that is selected. When the device is in Divided Clock mode, the frequencies on CKo0 - 3 cannot be greater than the input clock, CKi. For example, if the input clock is 8.192 MHz, the CKo2 pin will not produce a valid output clock and the CKo3 pin can only be programmed to output a 4.096 MHz or 8.192 MHz clock signal.

The device also delivers positive or negative output frame pulse and ST-BUS/GCI-Bus output clock formats via the programming of various bits in the Output Clock and Frame Pulse Selection Register (OCFSR). By default, the device delivers the negative output clock format. The ZL50020 can also deliver GCI-Bus format output frame pulses by programming bits of the Output Clock and Frame Pulse Selection Register (OCFSR). As there is a separate bit setting for each frame pulse output, some of the outputs can be set to operate in ST-BUS mode and others in GCI-Bus mode.

The following figures describe the usage of the FPO0P, FPO1P, FPO2P, FPO3P, CKO0P, CKO1P, CKO2P and CKO3P bits to generate the FPo0 - 3 and CKo0 - 3 timing.

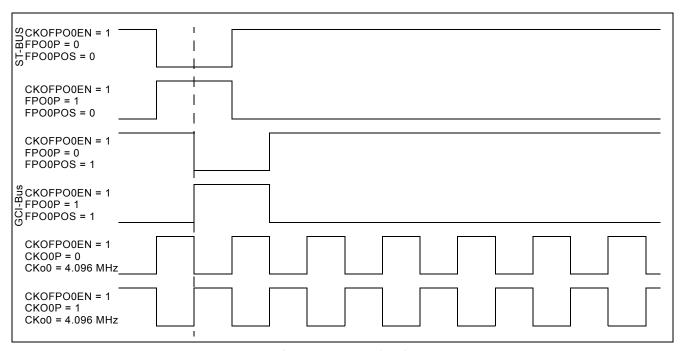


Figure 7 - Output Timing for CKo0 and FPo0

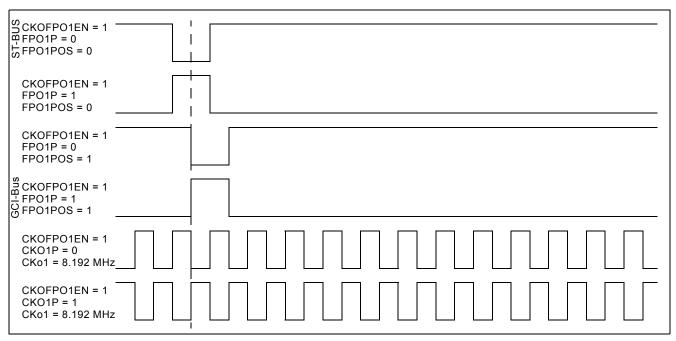


Figure 8 - Output Timing for CKo1 and FPo1

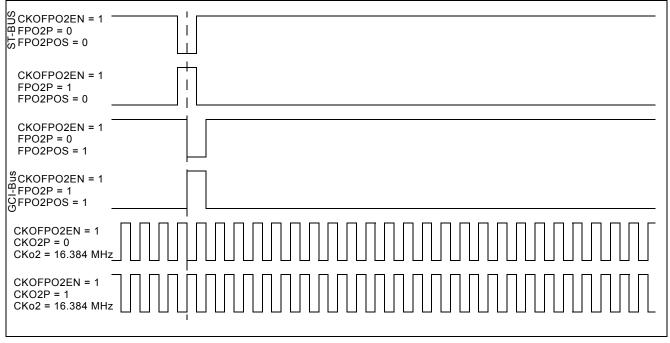


Figure 9 - Output Timing for CKo2 and FPo2

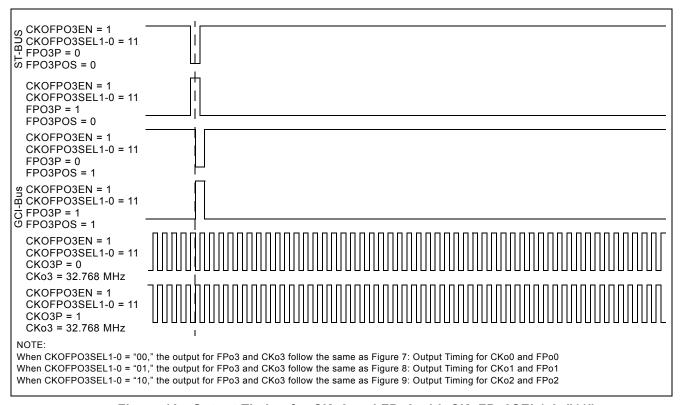


Figure 10 - Output Timing for CKo3 and FPo3 with CKoFPo3SEL1-0="11"

7.0 Data Input Delay and Data Output Advancement

Various registers are provided to adjust the input delay and output advancement for each input and output data stream. The input bit delay and output bit advancement can vary from 0 to 7 bits for each individual stream.

If input delay of less than a bit is desired, different sampling points can be used to handle the adjustments. The sampling point can vary from 1/4 to 4/4 with a 1/4-bit increment for all input streams, unless the stream is operating at 16.384 Mbps, in which case the fractional bit delay has a 1/2-bit increment. By default, the sampling point is set to the 3/4-bit location for non-16.384 Mbps data rates and the 1/2-bit location for the 16.384 Mbps data rate.

The fractional output bit advancement can vary from 0 to 3/4 bits, again with a 1/4-bit increment unless the output stream is operating at 16.384 Mbps, in which case the output bit advancement has a 1/2-bit increment from 0 to 1/2 bit. By default, there is 0 output bit advancement.

Although input delay or output advancement features are available on streams which are operating in bi-directional mode it is not recommended, as it can easily cause bus contention. If users require this function, special attention must be given to the timing to ensure contention is minimized.

7.1 Input Bit Delay Programming

The input bit delay programming feature provides users with the flexibility of handling different wire delays when designing with source streams for different devices.

By default, all input streams have zero bit delay, such that bit 7 is the first bit that appears after the input frame boundary (assuming ST-BUS formatting). The input delay is enabled by STIN[n]BD2-0 (bits 8 - 6) in the Stream Input Control Register 0 - 31 (SICR0 - 31) as described in Table 24 on page 50. The input bit delay can range from 0 to 7 bits.

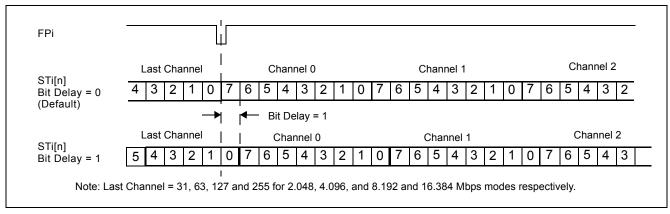


Figure 11 - Input Bit Delay Timing Diagram (ST-BUS)

7.2 Input Bit Sampling Point Programming

In addition to the input bit delay feature, the ZL50020 allows users to change the sampling point of the input bit by programming STIN[n]SMP 1-0 (bits 5 - 4) in the Stream Input Control Register 0 - 31 (SICR0 - 31). For input streams operating at any rate except 16.384 Mbps, the default sampling point is at 3/4 bit and users can change the sampling point to 1/4, 1/2, 3/4 or 4/4 bit position. When the stream is operating at 16.384 Mbps, the default sampling point is 1/2 bit and can be adjusted to a 4/4 bit position.

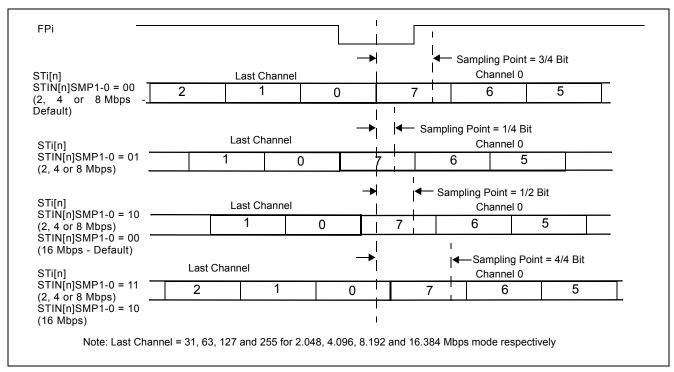


Figure 12 - Input Bit Sampling Point Programming

The input delay is controlled by STIN[n]BD2-0 (bits 8 - 6) to control the bit shift and STIN[n]SMP1 - 0 (bits 5 - 4) to control the sampling point in the Stream Input Control Register 0 - 31 (SICR0 - 31).

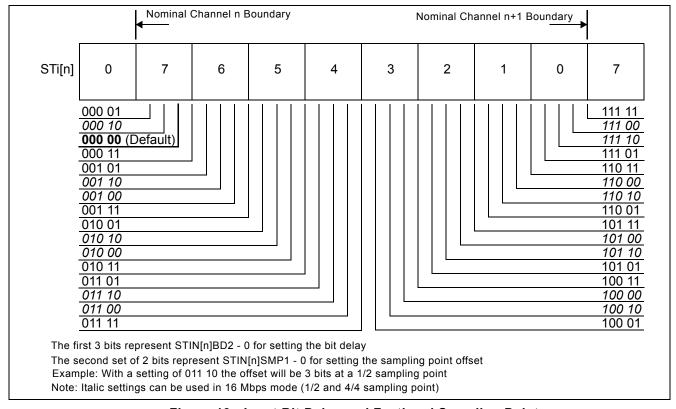


Figure 13 - Input Bit Delay and Factional Sampling Point

7.3 Output Advancement Programming

This feature is used to advance the output data of individual output streams with respect to the output frame boundary. Each output stream has its own bit advancement value which can be programmed in the Stream Output Control Register 0 - 31 (SOCR0 - 31).

By default, all output streams have zero bit advancement such that bit 7 is the first bit that appears after the output frame boundary (assuming ST-BUS formatting). The output advancement is enabled by STO[n]AD 2 - 0 (bits 6 - 4) of the Stream Output Control Register 0 - 31 (SOCR0 - 31) as described in Table 26 on page 54. The output bit advancement can vary from 0 to 7 bits.

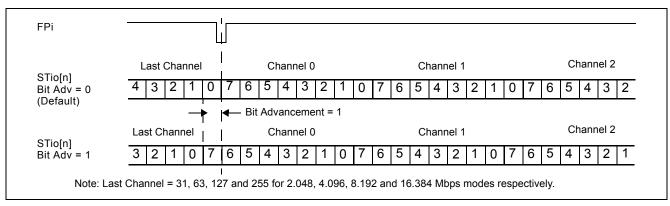


Figure 14 - Output Bit Advancement Timing Diagram (ST-BUS)

7.4 Fractional Output Bit Advancement Programming

In addition to the output bit advancement, the device has a fractional output bit advancement feature that offers better resolution. The fractional output bit advancement is useful in compensating for varying parasitic load on the serial data output pins.

By default all of the streams have zero fractional bit advancement such that bit 7 is the first bit that appears after the output frame boundary. The fractional output bit advancement is enabled by STO[n]FA 1 - 0 (bits 8 - 7) in the Stream Output Control Register 0 - 31 (SOCR0 - 31). For all streams running at any data rate except 16.384 Mbps the fractional bit advancement can vary from 0, 1/4, 1/2 to 3/4 bits. For streams operating at 16.384 Mbps, the fractional bit advancement can be set to either 0 or 1/2 bit.

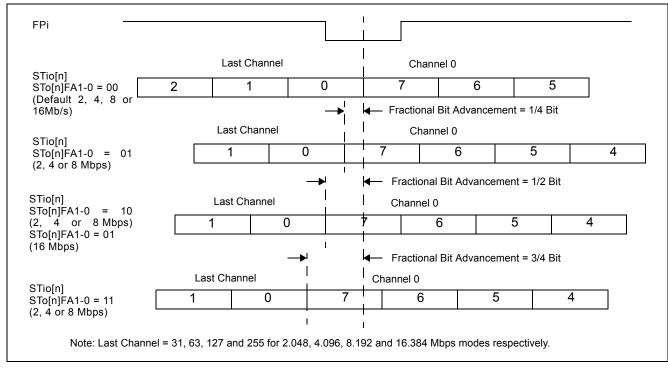


Figure 15 - Output Fractional Bit Advancement Timing Diagram (ST-BUS)

7.5 External High Impedance Control Advancement

The external high impedance signals can be programmed to better match the timing required by the external buffers. By default, the output timing of the STOHZ signals follows the programmed channel delay and bit offset of their corresponding ST-BUS/GCI-Bus output streams. In addition, for all high impedance streams operating at any data rate except 16.384 Mbps, the user can advance the STOHZ signals a further 0, 1/4, 1/2, 3/4 or 4/4 bits by programming STOHZ[n]A 2 - 0 (bit 11 - 9) in the Stream Output Control Register. When the stream is operating at 16.384 Mbps, the additional STOHZ advancement can be set to 0, 1/2 or 4/4 bits by programming the same register.

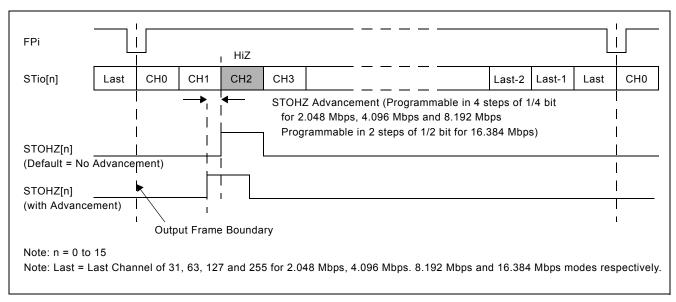


Figure 16 - Channel Switching External High Impedance Control Timing

8.0 Data Delay Through the Switching Paths

The switching of information from the input serial streams to the output serial streams results in a throughput delay. The device can be programmed to perform timeslot interchange functions with different throughput delay capabilities on a per-channel basis. For voice applications, select variable throughput delay to ensure minimum delay between input and output data. In wideband data applications, select constant delay to maintain the frame integrity of the information through the switch. The delay through the device varies according to the type of throughput delay selected by the V/\overline{C} (bit 14) in the Connection Memory Low when CMM = 0.

8.1 Variable Delay Mode

Variable delay mode causes the output channel to be transmitted as soon as possible. This is a useful mode for voice applications where the minimum throughput delay is more important than frame integrity. The delay through the switch can vary from 7 channels to 1 frame + 7 channels. To set the device into variable delay mode, VAREN (bit 4) in the Control Register (CR) must be set before V/\overline{C} (bit 14) in the Connection Memory Low when CMM = 0. If the VAREN bit is not set and the device is programmed for variable delay mode, the information read on the output stream will not be valid.

In variable delay mode, the delay depends on the combination of the source and destination channels of the input and output streams.

m = input channel number	n-m <= 0	0 < n-m < 7	r	n-m = 7	n-m > 7
n = output channel number			STio < STi	STio >= STi	
T = Delay between input and output	1 frame - (m-n)	1 frame	+ (n-m)	n-m	

Table 4 - Delay for Variable Delay Mode

For example, if Stream 4 Channel 2 is switched to Stream 5 Channel 9 with variable delay, the data will be output in the same 125 μ s frame. Contrarily, if Stream 6 Channel 1 is switched to Stream 9 Channel 3, the information will appear in the following frame.

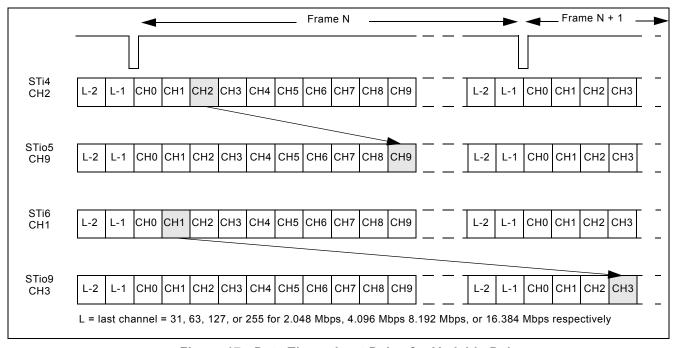


Figure 17 - Data Throughput Delay for Variable Delay

8.2 Constant Delay Mode

In this mode, frame integrity is maintained in all switching configurations. The delay though the switch is 2 frames - Input Channel + Output Channel. This can result in a minimum of 1 frame + 1 channel delay if the last channel on a stream is switched to the first channel of a stream. The maximum delay is 3 frames - 1 channel. This occurs when the first channel of a stream is switched to the last channel of a stream. The constant delay mode is available for all output channels.

The data throughput delay is expressed as a function of ST-BUS/GCI-Bus frames, input channel number (m) and output channel number (n). The data throughput delay (T) is:

$$T = 2 \text{ frames} + (n - m)$$

The constant delay mode is controlled by V/C (bit 14) in the Connection Memory Low when CMM = 0. When this bit is set low, the channel is in constant delay mode. If VAREN (bit 4) in the Control Register (CR) is set (to enable variable throughput delay on a chip-wide basis), the device can still be programmed to operate in constant delay mode.

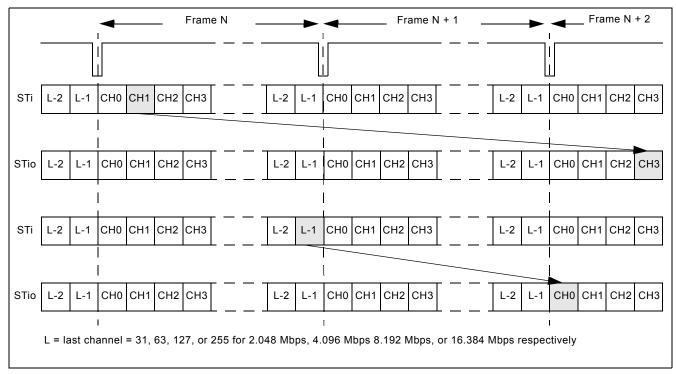


Figure 18 - Data Throughput Delay for Constant Delay

9.0 Connection Memory Description

The connection memory consists of two blocks, Connection Memory Low (CM_L) and Connection Memory High (CM_H). The CM_L is 16 bits wide and is used for channel switching and other special modes. The CM_H is 5 bits wide and is used for the voice coding function. When UAEN (bit 15) of the Connection Memory Low (CM_L) is low, μ -law/A-law conversion will be turned off and the contents of CM_H will be ignored. Each connection memory location of the CM_L or CM_H can be read or written via the 16 bit microprocessor port within one microprocessor access cycle. See Table 31 on page 57 for the address mapping of the connection memory. Any unused bits will be reset to zero on the 16-bit data bus.

For the normal channel switching operation, CMM (bit 0) of the Connection Memory Low (CM_L) is programmed low. SCA7 - 0 (bits 8 - 1) indicate the source (input) channel address and SSA4 - 0 (bits 13 - 9) indicate the source (input) stream address. The 5-bit contents of the CM_H will be ignored during the normal channel switching mode without the μ -law/A-law conversion when UAEN (bit 15) of the Connection Memory Low (CM_L) is set to zero. If μ -law/A-law conversion is required, the CM_H bits must be programmed first to provide the voice/data information, the input coding law and the output coding law before the assertion of UAEN (bit 15) in the Connection Memory Low.

When CMM (bit 0) of the Connection Memory Low (CM_L) is programmed high, the ZL50020 will operate in one of the special modes described in Table 33 on page 58. When the per-channel message mode is enabled, MSG7 - 0 (bit 10 - 3) in the Connection Memory Low (CM_L) will be output via the serial data stream as message output data. When the per-channel message mode is enabled, the μ -law/A-law conversion can also be enabled as required.

10.0 Connection Memory Block Programming

This feature allows for fast initialization of the connection memory after power up.

10.1 Memory Block Programming Procedure

- 1. Set MBPE (bit 3) in the Control Register (CR) from low to high.
- 2. Configure BPD2 0 (bits 3 1) in the Internal Mode Selection (IMS) register to the desired values to be loaded into CM L.
- 3. Start the block programming by setting MBPS (bit 0) in the Internal Mode Selection Register (IMS) high. The values stored in BPD2 0 will be loaded into bits 2 0 of all CM_L positions. The remaining CM_L locations (bits 15 3) and the programmable values in the CM_H (bits 4 0) will be loaded with zero values.

The following tables show the resulting values that are in the CM_L and CM_H connection memory locations.

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	BPD2	BPD1	BPD0

Table 5 - Connection Memory Low After Block Programming

Bit	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
Value	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0	0

Table 6 - Connection Memory High After Block Programming

Note: Bits 15 to 5 are reserved in Connection Memory High and should always be 0.

It takes at least two frame periods (250 μs) to complete a block program cycle.

MBPS (bit 0) in the Control Register (CR) will automatically reset to a low position after the block programming process has completed.

MBPE (bit 3) in the Internal Mode Selection (IMS) register must be cleared from high to low to terminate the block programming process. This is not an automatic action taken by the device and must be performed manually.

Note: Once the block program has been initiated, it can be terminated at any time prior to completion by setting MBPS (bit 0) in the Control Register (CR) or MBPE (bit 3) in the Internal Mode Selection (IMS) register to low. If the MBPE bit was used to terminate the block programming, the MBPS bit will have to be set low before enabling other device operations.

11.0 Device Operation in Divided Clock and Multiplied Clock Modes

This device has two main operating modes - Divided Clock mode and Multiplied Clock mode.

In Multiplied Clock mode, output clocks and frame pulses are generated from an internal high-speed clock synchronized to CKi and FPi. Therefore, all specified output clock rates and data rates are available on CKo0-3 and STio0-31. In Divided Clock mode, output clocks and frame pulses are directly divided from CKi/FPi. Therefore, the output clock rate cannot exceed the CKi rate (the output data rates are also limited as per Table 1). The input data rate cannot exceed the CKi rate in either Multiplied or Divided Clock modes, because input data are always sampled directly by CKi.

Table 7, "ZL50020 Operating Modes" on page 32 summarizes the different modes of operation available within the ZL50020. Each Major mode (explained below) has an associated Minor mode that is determined by setting the MODE_4M Input Control pins and the OPM bit in the Control Register (Table 13, "Control Register (CR) Bits" on page 39) indicated in the table.

Devic	Device		Input Pins		Output Clock	Data Pins		
Operating	Mode	Control	Signal	Bit	Reference Lock	Enabled	(Clock Source
Major	Minor	MODE_4M [1:0]	CKi	OPM	CKo0-3	CKo0-3	STi	STo
Divided	4 M	11	4 M	0	CKi	Yes	CKi	CKo0-3
Clock	8/16 M	00	8/16 M					(CKi)
Multiplied	4 M	11	4 M	1	CKi MULT			CKo0-3
Clock	8/16 M	00	8/16 M					(CKi MULT)

Legend:

Reference Lock Refers to what signal the output pins are locked to: Cki = Bypass. Cki is passed directly through to CKo0-3.

Cki MULT = Cki is passed through clock multiplier to CKo0-3.

Clock Source Refers to which clock samples STi and which clock outputs STo; STi applies when STio is input; STo applies when STio is output.

Table 7 - ZL50020 Operating Modes

11.1 Divided Clock Mode Operation

When the device is in Divided Clock mode, STio0 - 31 are driven by CKi. In this mode, the output streams and clocks have the same amount of jitter as the input clock (CKi), but the output data rate cannot exceed the input data rate defined by CKi. For example, if CKi is 4.096 MHz, the input and output data rate cannot be higher than 2.048 Mbps, and the generated output clock rates cannot exceed 4.096 MHz.

11.2 Multiplied Clock Mode Operation

When the device is in Multiplied Clock mode, device hardware is used to multiply CKi internally. STio0 - are driven by this internally generated clock. In this mode, the output clocks and data can run at any of the specified rates, but they may have different jitter characteristics from the input clock (CKi). The input data rates are still limited by the CKi rate (as per Table 1), as input data are always sampled directly by CKi.

11.3 Output Clock Frequencies

The device can generate a limited number of clock and frame pulse output signals. All signals are synchronous to each other and are locked to the input CKi and FPi. The device can provide outputs with the following frequencies, with the exception that when in Divided Clock mode, the output clock rate cannot exceed the input CKi rate.

CKo0	4.096 MHz
CKo1	8.192 MHz
CKo2	16.384 MHz
CKo3	4.096 MHz, 8.192 MHz, 16.384 MHz or 32.768 MHz
FPo0	8 kHz (244 ns wide pulse)
FPo1	8 kHz (122 ns wide pulse)
FPo2	8 kHz (61 ns wide pulse)
FPo3	8 kHz (244 ns, 122 ns, 61 ns or 30 ns wide pulse)

Table 8 - Generated Output Frequencies

X Don't care or not applicable.

12.0 Microprocessor Port

The device provides access to the internal registers, connection memories and data memories via the microprocessor port. The microprocessor port is capable of supporting both Motorola and Intel non-multiplexed microprocessors. The microprocessor port consists of a 16-bit parallel data bus (D15 - 0), 14 bit address bus (A13 - 0) and six control signals (MOT_INTEL, CS, DS_RD, R/W_WR and DTA_RDY).

The data memory can only be read from the microprocessor port. For a data memory read operation, D7 - 0 will be used and D15 - 8 will output zeros.

For a CM_L read or write operation, all bits (D15 - 0) of the data bus will be used. For a CM_H write operation, D4 - 0 of the data bus must be configured and D15 - 5 are ignored. D15 - 5 must be driven either high or low. For a CM_H read operation, D4 - 0 will be used and D15 - 5 will output zeros.

Refer to Figure 20 on page 63, Figure 21 on page 64, Figure 22 on page 65 and Figure 23 on page 66 for the microprocessor timing.

13.0 Device Reset and Initialization

The RESET pin is used to reset the ZL50020. When this pin is low, the following functions are performed:

- · synchronously puts the microprocessor port in a reset state
- tristates the STio0 31 outputs
- · drives the STOHZ0 15 outputs to high
- preloads all internal registers with their default values (refer to the individual registers for default values)
- · clears all internal counters

13.1 Power-up Sequence

The recommended power-up sequence is for the V_{DD_IO} supply (normally +3.3 V) to be established before the power-up of the V_{DD_CORE} supply (normally +1.8 V). The V_{DD_CORE} supply may be powered up at the same time as V_{DD_IO} , but should not "lead" the V_{DD_IO} supply by more than 0.3 V.

13.2 Device Initialization on Reset

Upon power up, the ZL50020 should be initialized as follows:

- Set the ODE pin to low to disable the STio0 31 outputs and to drive STOHZ0 15 to high
- Set the TRST pin to low to disable the JTAG TAP controller
- Reset the device by pulsing the \overline{RESET} pin to zero for longer than 1 μs
- After releasing the RESET pin from low to high, wait for a certain period of time (see Note below) for the device to stabilize from the power down state before the first microprocessor port access can occur
- Program CKIN1 0 (bit 6 -5) in the Control Register (CR) to define the frequency of the CKi and FPi inputs
- Wait at least 500 μs prior to the next microport access (see Note below)
- Use the block programming mode to initialize the connection memory
- Release the ODE pin from low to high after the connection memory is programmed

Note: If CKi is 16.384 MHz, the waiting time is 500 μ s; if CKi is 8.192 MHz, the waiting time is 1 ms; if CKi is 4.096 MHz, the waiting time is 2 ms.

13.3 Software Reset

In addition to the hardware reset from the RESET pin, the device can also be reset by using software reset SRSTSW (bit 1) in the Software Reset Register (SRR).

14.0 Pseudo Random Bit Generation and Error Detection

The ZL50020 has one Bit Error Rate (BER) transmitter and one BER receiver for each pair of input and output streams, resulting in 32 transmitters connected to the output streams and 32 receivers associated with the input streams. Each transmitter can generate a BER sequence with a pattern of 2^{15} -1 pseudorandom code (ITU O.151). Each transmitter can start at any location on the stream and will last for a minimum of 1 channel to a maximum of 1 frame time (125 μ s). The BER receivers and transmitters are enabled by programming the RBEREN (bit 5) and TBEREN (bit 4) in the IMS register. In order to save power, the 32 transmitters and/or receivers can be disabled. (This is the default state.)

Multiple connection memory locations can be programmed for BER tests such that the BER patterns can be transmitted for multiple consecutive output channels. If consecutive input channels are not selected, the BER receiver will not compare the bit patterns correctly. The number of output channels which the BER pattern occupies has to be the same as the number of channels defined in the BER Length Register (BRLR) which defines how many BER channels are to be monitored by the BER receiver.

For each input stream, there is a set of registers for the BER test. The registers are as follows:

- BER Receiver Control Register (**BRCR**) ST[n]CBER (bit 1) is used to clear the Bit Receiver Error Register (BRER). ST[n]SBER (bit 0) is used to enable the per-stream BER receiver.
- BER Receiver Start Register (**BRSR**) ST[n]BRS7 0 (bit 7 0) defines the input channel from which the BER sequence will start to be compared.
- BER Receiver Length Register (**BRLR**) ST[n]BL8 0 (bit 8 0) define how many channels the sequence will last. Depending on the data rate being used, the BER test can last for a maximum of 32, 64, 128 or 256channels at the data rates of 2.048, 4.096, 8.192or 16.384Mbps, respectively. The minimum length of the BER test is a single channel. The user must take care to program the correct channel length for the BER test so that the channel length does not exceed the total number of channels available in the stream.
- BER Receiver Error Register (BRER) This read-only register contains the number of counted errors. When
 the error count reaches 0xFFFF, the BER counter will stop updating so that it will not overflow. ST[n]CBER
 (bit 1) in the BER Receiver Control Register is used to reset the BRER register.

For normal BER operation, CMM (bit 0) must be 1 in the Connection Memory Low (CM_L). PCC1 - 0 (bits 2 - 1) in the Connection Memory Low must be programmed to "10" to enable the per-stream based BER transmitters. For each stream, the length (or total number of channels) of BER testing can be as long as one whole frame, but the channels MUST be consecutive. Upon completion of programming the connection memory, the corresponding BER receiver can be started by setting ST[n]SBER (bit 0) in the BRCR to high. There must be at least 2 frames (250 μ s) between completion of connection memory programming and starting the BER receiver before the BER receiver can correctly identify BER errors. A 16 bit BER counter is used to count the number of bit errors.

15.0 PCM A-law/ μ -law Translation

The ZL50020 provides per-channel code translation to be used to adapt pulse code modulation (PCM) voice or data traffic between networks which use different encoding laws. Code translation is valid in both Connection Mode and Message Mode.

In order to use this feature, the Connection Memory High (CM_H) entry for the output channel must be programmed. $\overline{V/D}$ (bit 4) defines if the traffic in the channel is voice or data. Setting ICL1 - 0 (bits 3 - 2) programs the input coding law and OCL1 - 0 (bits 1- 0) programs the output coding law as shown in Table 9.

The different code options are:

Input Coding (ICL1- 0)	Output Coding (OCL1 - 0)	Voice Coding (V/D bit = 0)	Data Coding (V/D bit = 1)
00	00	ITU-T G.711 A-law	No code
01	01	ITU-T G.711 μ-law	Alternate Bit Inversion (ABI)
10	10	A-law without Alternate Bit Inversion (ABI)	Inverted Alternate Bit Inversion (ABI)
11	11	μ-law without Magnitude Inversion (MI)	All bits inverted

Table 9 - Input and Output Voice and Data Coding

For voice coding options, the ITU-T G.711 A-law and ITU-T G.711 μ -law are the standard rules for encoding. A-law without Alternate Bit Inversion (ABI) is an alternative code that does not invert the even bits (6, 4, 2, 0). μ -law without Magnitude Inversion (MI) is an alternative code that does not perform inversion of magnitude bits (6, 5, 4, 3, 2, 1, 0).

When transferring data code, the option "no code" does not invert the bits. The Alternate Bit Inversion (ABI) option inverts the even bits (6, 4, 2, 0) while the Inverted Alternate Bit Inversion (ABI) inverts the odd bits (7, 5, 3, 1). When the "All bits inverted" option is selected, all of the bits (7, 6, 5, 4, 3, 2, 1, 0) are inverted.

The input channel and output channel encoding law are configured independently. If the output channel coding is set to be different from the input channel, the ZL50020 performs translation between the two standards. If the input and output encoding laws are set to the same standard, no translation occurs. As the $\overline{V/D}$ (bit 4) of the Connection Memory High (CM_H) must be set on a per-channel basis, it is not possible to translate between voice and data encoding laws.

16.0 Quadrant Frame Programming

By programming the Stream Input Quadrant Frame Registers (SIQFR0 - 31), users can divide one frame of input data into four quadrant frames and can force the LSB or MSB of every input channel in these quadrants to one or zero for robbed-bit signaling. The four quadrant frames are defined as follows:

Data Rate	Quadrant 0	Quadrant 1	Quadrant 2	Quadrant 3
2.048 Mbps	Channel 0 - 7	Channel 8 - 15	Channel 16 - 23	Channel 24 - 31
4.096 Mbps	Channel 0 - 15	Channel 16 - 31	Channel 32 - 47	Channel 48 - 63
8.192 Mbps	Channel 0 - 31	Channel 32 - 63	Channel 64 - 95	Channel 96 - 127
16.384 Mbps	Channel 0 - 63	Channel 64 - 127	Channel 128 - 191	Channel 192 - 255

Table 10 - Definition of the Four Quadrant Frames

When the quadrant frame control bits, STIN[n]Q3C2 - 0 (bit 11 - 9), STIN[n]Q2C2 - 0 (bit 8 - 6), STIN[n]Q1C2 - 0 (bit 5 - 3) or STIN[n]Q1C2 - 0 (bit 2 - 0), are set, the LSB or MSB of every input channel in the quadrant is forced to "1" or "0" as shown by the following table:

STIN[n]Q[y]C[2:0]	Action
0xx	Normal Operation
100	Replaces LSB of every channel in Quadrant y with '0'
101	Replaces LSB of every channel in Quadrant y with '1'
110	Replaces MSB of every channel in Quadrant y with '0'
111	Replaces MSB of every channel in Quadrant y with '1'
Note: y = 0, 1, 2, 3	

Table 11 - Quadrant Frame Bit Replacement

Note that Quadrant Frame Programming and BER reception cannot be used simultaneously on the same input stream.

17.0 JTAG Port

The JTAG test port is implemented to meet the mandatory requirements of the IEEE-1149.1 (JTAG) standard. The operation of the boundary-scan circuitry is controlled by an external Test Access Port (TAP) Controller.

17.1 Test Access Port (TAP)

The Test Access Port (TAP) accesses the ZL50020 test functions. It consists of three input pins and one output pin as follows:

- Test Clock Input (TCK) TCK provides the clock for the test logic. TCK does not interfere with any on-chip
 clock and thus remains independent in the functional mode. TCK permits shifting of test data into or out of
 the Boundary-Scan register cells concurrently with the operation of the device and without interfering with
 the on-chip logic.
- Test Mode Selection Inputs (TMS) The TAP Controller uses the logic signals received at the TMS input to
 control test operations. The TMS signals are sampled at the rising edge of the TCK pulse. This pin is
 internally pulled to high when it is not driven from an external source.
- **Test Data Input (TDi)** Serial input data applied to this port is fed either into the instruction register or into a test data register, depending on the sequence previously applied to the TMS input. The registers are described in a subsequent section. The received input data is sampled at the rising edge of the TCK pulse. This pin is internally pulled to high when it is not driven from an external source.
- Test Data Output (TDo) Depending on the sequence previously applied to the TMS input, the contents of either the instruction register or test data register are serially shifted out towards TDo. The data from TDo is clocked on the falling edge of the TCK pulses. When no data is shifted through the boundary scan cells, the TDo driver is set to a high impedance state.
- Test Reset (TRST) Resets the JTAG scan structure. This pin is internally pulled to high when it is not driven from an external source.

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17.2 Instruction Register

The ZL50020 uses the public instructions defined in the IEEE-1149.1 standard. The JTAG interface contains a four-bit instruction register. Instructions are serially loaded into the instruction register from the TDi when the TAP Controller is in its shifted-OR state. These instructions are subsequently decoded to achieve two basic functions: to select the test data register that may operate while the instruction is current and to define the serial test data register path that is used to shift data between TDi and TDo during data register scanning.

17.3 Test Data Registers

As specified in the IEEE-1149.1 standard, the ZL50020 JTAG interface contains three test data registers:

- The Boundary-Scan Register The Boundary-Scan register consists of a series of boundary-scan cells arranged to form a scan path around the boundary of the ZL50020 core logic.
- The Bypass Register The Bypass register is a single stage shift register that provides a one-bit path from TDi to TDo.
- The Device Identification Register The JTAG device ID for the ZL50020 is 0C36414B_H

Version	<31:28>	0000
Part Number	<27:12>	1100 0011 0110 0100
Manufacturer ID	<11:1>	0001 0100 101
LSB	<0>	1

17.4 BSDL

A Boundary Scan Description Language (BSDL) file is available from Zarlink Semiconductor to aid in the use of the IEEE-1149.1 test interface.

18.0 Register Address Mapping

Address	CPU	Register	Abbreviation	Reset By
A13 - A0	Access	Name		
0000 _H	R/W	Control Register	CR	Switch/Hardware
0001 _H	R/W	Internal Mode Selection Register	IMS	Switch/Hardware
0002 _H	R/W	Software Reset Register	SRR	Hardware Only
0003 _H	R/W	Output Clock and Frame Pulse Control Register	OCFCR	Hardware
0004 _H	R/W	Output Clock and Frame Pulse Selection Register	OCFSR	Hardware
0005 _H	R/W	FPo_OFF0 Register	FPOFF0	Hardware
0006 _H	R/W	FPo_OFF1 Register	FPOFF1	Hardware
0007 _H	R/W	FPo_OFF2 Register	FPOFF2	Hardware
0010 _H	R Only	Internal Flag Register	IFR	Switch/Hardware
0011 _H	R Only	BER Error Flag Register 0	BERFR0	Switch/Hardware
0012 _H	R Only	BER Error Flag Register 1	BERFR1	Switch/Hardware
0013 _H	R Only	BER Receiver Lock Register 0	BERLR0	Switch/Hardware
0014 _H	R Only	BER Receiver Lock Register 1	BERLR1	Switch/Hardware
0100 _H - 011F _H	R/W	Stream Input Control Registers 0 - 31	SICR0 - 31	Switch/Hardware
0120 _H - 013F _H	R/W	Stream Input Quadrant Frame Registers 0 - 31	SIQFR0 - 31	Switch/Hardware
0200 _H - 021F _H	R/W	Stream Output Control Registers 0 - 31	SOCR0 - 31	Switch/Hardware
0300 _H - 031F _H	R/W	BER Receiver Start Registers 0 - 31	BRSR0 - 31	Switch/Hardware
0320 _H - 033F _H	R/W	BER Receiver Length Registers 0 - 31	BRLR0 - 31	Switch/Hardware
0340 _H - 035F _H	R/W	BER Receiver Control Registers 0 - 31	BRCR0 - 31	Switch/Hardware
0360 _H - 037F _H	R Only	BER Receiver Error Registers 0 - 31	BRER0 - 31	Switch/Hardware

Table 12 - Address Map for Registers (A13 = 0)

19.0 Detailed Register Description

	al Read/\ Value: 00	Write Addre	ess: 000	0 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	OPM	0	FPIN POS	CKINP	FPINP	CKIN 1	CKIN 0	VAR EN	MBPE	OSB	MS1	MS0

Bit	Name			Description		
15 - 12	Unused	Reserved.	In normal functiona	al mode, these bits MUS	T be set to zero.	
11	OPM	Operation This bit is to Operating N	Mode. used to set the dev Modes" on page 32	ice in Master/Slave ope for more details.	ration. Refer to Table	7, "ZL50020
10	Unused	Reserved.	In normal functiona	al mode, this bits MUST	be set to zero.	
9	FPINPOS	When this b	e Pulse (FPi) Pos bit is low, FPi strado bit is high, FPi starts	ition lles frame boundary (as s from frame boundary (defined by ST-BUS). as defined by GCI-Bu	s)
8	CKINP	When this b		lling edge aligns with the ising edge aligns with the		
7	FPINP	When this		rity It frame pulse FPi has frame pulse FPi has the		
6 - 5	CKIN1 - 0	Input Cloc	k (CKi) and Frame	Pulse (FPi) Selection		
			CKIN1 - 0	FPi Active Period	CKi	
			00	61 ns	16.384 MHz	
			01	122 ns	8.192 MHz	
			10	244 ns	4.096 MHz	
			11	Reser	ved	
				4M1 pins, as described input clock mode.	in "Pin Description" or	n page 10,
4	VAREN	When this b	elay Mode Enable bit is low, the variab bit is high, the varia	le delay mode is disable ble delay mode is enabl	ed on a device-wide b ed on a device-wide b	asis. pasis.
3	MBPE	When this	ock Programming bit is high, the core connection memo	g Enable Inection memory block Iry. When it is low, the mo	programming mode i emory block programi	s enabled to ming mode is

Table 13 - Control Register (CR) Bits

	ıl Read/ /alue: 00	Write Add	ress: 00	00 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	OPM	0	FPIN POS	CKINP	FPINP	CKIN 1	CKIN 0	VAR EN	MBPE	OSB	MS1	MS0
	1		ı												
Bit	N	ame						De	scripti	on					
2	C	SB	This	ut Stand bit enab ribes the	les the	STio(erial ou	ıtputs. ٦	he fol	lowing	table
				RESET Pin			ODE Pin	OSB Bit	S	STio0 - 31			STOH	Z0 - 15	
				0	>	<	Х	Х		HiZ			Driven High		
				1			Х	Х		HiZ			Driver	n High	
				1	()	0	Χ		HiZ			Driver	n High	
				1	(1	0		HiZ				n High	
				1	()	1	1	(Cont	Active rolled b	y CM)	(C	Act ontrolle		M)
				: Unused R0 - 31	•		ams are	tristate	d (STio	= HiZ	STOH	IZ = Dri	ven Hi	igh). R	efer to
1 - 0	MS	61 - 0	Thes	ory Sele e two bit or acces	s are	used t	o select	connec	tion me	emory I	ow, co	nnectio	n high	or dat	a men
					MS1 - (0			Memo	ry Sele	ction				
					00			Connec	tion Me	mory Lo	w Rea	d/Write		1	
					01			Connec	tion Mei	mory Hi	gh Rea	d/Write		1	
					10				Data M	lemory	Read				
					11				R	eserve	i				

Table 13 - Control Register (CR) Bits (continued)

0	0	0	0											
				0	0	STIO_ PD_EN	BDH	BDL	RBER EN	TBER EN	BPD 2	BPD 1	BPD 0	MBPS
N	lame							Descr	iption					
U	nused	1	Reserv	ed. In	norma	al functio	nal mod	le, thes	e bits N	IUST b	e set t	o zero	-	
STI	O_PD EN	١ ا	STio Pull-down Enable When this bit is low, the pull-down resistors on all STio pads will be disabled. When this bit is high, the pull-down resistors on all STio pads will be enabled. Bi-directional Control for Streams 16-31											
ا	BDH	ı	Bi-dire	ctiona	l Con	trol for S								
					BDH STio16 - 31 Operation									
			0 normal operation: STi16-31 are inputs STio16-31 are outputs											
						1	STi1	6-31 tie	d low int	ernally				
	BDL	1	Bi-dire	ctiona	l Con	trol for S	Streams	0-15						
						BDL	s	Tio0 - 1	5 Opera	tion				
						0		STi0-15	are inpu	uts				
						1	STi	0-15 tied	l low inte	ernally				
	STI	Unused STIO_PD	Unused STIO_PD_ EN BDH	Unused Reserv STIO_PD_ EN When the When the Strick	Unused Reserved. In STIO_PD_ EN STio Pull-dov When this bit is When this bit is BDH Bi-directiona	Unused Reserved. In normal STIO_PD_ EN STio Pull-down En When this bit is low, When this bit is high BDH Bi-directional Control	Unused STIO_PD_ EN STio Pull-down Enable When this bit is low, the pull- When this bit is high, the pull- When this bit is high, the pull- BDH Bi-directional Control for S BDH 0 BDL Bi-directional Control for S BDL BDL BDL BDL BDL BDL BDL	Unused STIO_PD_ EN STio Pull-down Enable When this bit is low, the pull-down re When this bit is high, the pull-down BDH Bi-directional Control for Streams BDH STI 0 SSI 1 bi- STII STII BDL SI 0 SSI 1 BDL SI 1 BDL SI 1 BI-DI STII STI	Unused Reserved. In normal functional mode, these STIO_PD_ EN STio Pull-down Enable When this bit is low, the pull-down resistors When this bit is high, the pull-down resistors BDH Bi-directional Control for Streams 16-31 BDH STio16 - 3	Unused Reserved. In normal functional mode, these bits Normal STIO_PD_EN STIO_PD_EN When this bit is low, the pull-down resistors on all When this bit is high, the pull-down resistors on all When this bit is high, the pull-down resistors on all Stine STIO STIO STIO STIO STIO STIO STIO STIO	Unused Reserved. In normal functional mode, these bits MUST b STIO_PD_ EN STio Pull-down Enable When this bit is low, the pull-down resistors on all STio pa When this bit is high, the pull-down resistors on all STio pa When this bit is high, the pull-down resistors on all STio pa When this bit is high, the pull-down resistors on all STio pa When this bit is low, the pull-down resistors on all STio pa BDH BDH BDH BDH BDH BDH BDH BDH	Unused Reserved. In normal functional mode, these bits MUST be set to STIO_PD_EN STio Pull-down Enable When this bit is low, the pull-down resistors on all STio pads will When this bit is high, the pull-down resistors on all STio pads will BDH Bi-directional Control for Streams 16-31 BDH STio16 - 31 Operation 0 normal operation: STio16-31 are outputs 1 bi-directional operation: STio16-31 are bi-directional BDL Bi-directional Control for Streams 0-15 BDL STio0 - 15 Operation 0 normal operation: STio-15 are inputs STio0-15 are outputs 1 bi-directional operation: STio15 are outputs 1 bi-directional operation: STio15 tied low internally	Unused Reserved. In normal functional mode, these bits MUST be set to zero STIO_PD_ EN STio Pull-down Enable When this bit is low, the pull-down resistors on all STio pads will be dis When this bit is high, the pull-down resistors on all STio pads will be e BDH Bi-directional Control for Streams 16-31 BDH STio16 - 31 Operation Onormal operation: STio16-31 are inputs STio16-31 are outputs 1 bi-directional operation: STio16-31 are bi-directional BDL Bi-directional Control for Streams 0-15 BDL STio0 - 15 Operation Onormal operation: STio-15 are inputs STio0-15 are outputs 1 bi-directional operation: STio1-15 are outputs 1 bi-directional operation: STio1-15 tied low internally	Unused Reserved. In normal functional mode, these bits MUST be set to zero. STIO_PD_ EN Stio Pull-down Enable When this bit is low, the pull-down resistors on all STio pads will be disabled. When this bit is high, the pull-down resistors on all STio pads will be enabled. BDH Stio16 - 31 Operation O normal operation: STi16-31 are inputs STi016-31 are outputs 1 bi-directional operation: STi16-31 tied low internally STio16-31 are bi-directional BDL Stio0 - 15 Operation O normal operation: STi0-15 are inputs STi0-15 are outputs 1 bi-directional operation: STi0-15 are outputs 1 bi-directional operation: STi0-15 tied low internally

Table 14 - Internal Mode Selection Register (IMS) Bits

PRBS Transmitter EnableWhen this bit is low, all the BER transmitters are disabled. To enable any BER transmitters, this bit **MUST** be high.

TBEREN

External Reset Va			dress: 0	001 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	STIO_ PD_EN	BDH	BDL	RBER EN	TBER EN	BPD 2	BPD 1	BPD 0	MBPS
Bit	ı	Name							Descr	iption					

		·
3 - 1	BPD2 - 0	Block Programming Data These bits refer to the value to be loaded into the connection memory, whenever the memory block programming feature is activated. After the MBPE bit in the Control Register is set to high and the MBPS bit in this register is set to high, the contents of the bits BPD2 - 0 are loaded into bits 2 - 0 of the Connection Memory Low. Bits 15 - 3 of the Connection Memory Low and bits 15 - 0 of Connection Memory High are zeroed.
0	MBPS	Memory Block Programming Start: A zero to one transition of this bit starts the memory block programming function. The MBPS and BPD2 - 0 bits in this register must be defined in the same write operation. Once the MBPE bit in the Control Register is set to high, the device requires two frames to complete the block programming. After the programming function has finished, the MBPS bit returns to low, indicating the operation is completed. When MBPS is high, MBPS or MBPE can be set to low to abort the programming operation. Whenever the microprocessor writes a one to the MBPS bit, the block programming function is started. As long as this bit is high, the user must maintain the same logical value to the other bits in this register to avoid any change in the device setting.

Table 14 - Internal Mode Selection Register (IMS) Bits (continued)

ZL50020 Data Sheet

	: 0000 _H		s: 0002												
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	0	0	0	0	0	0	0	SRST SW	0

Bit	Name	Description
15 - 2	Unused	Reserved In normal functional mode, these bits MUST be set to zero.
1	SRSTSW	Software Reset Bit for Switch When this bit is low, switching blocks are in normal operation. When this bit is high, switching blocks are in software reset state. Refer to Table 12, "Address Map for Registers (A13 = 0)" on page 32 for details regarding which registers are affected.
0	Unused	Reserved In normal functional mode, these bits MUST be set to zero.

Table 15 - Software Reset Register (SRR) Bits

	nal Read Value:	d/Write A	Address	: 0003 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	FPOF2 EN	FPOF1 EN	FPOF0 EN	0	0	CKO FPO3 EN	CKO FPO2 EN	CKO FPO1 EN	CKO FPO0 EN

Bit	Name	Description
15 - 9	Unused	Reserved In normal functional mode, these bits MUST be set to zero.
8	FPOF2EN	FPo_OFF2 Enable When this bit is high, output frame pulse FPo_OFF2 When this bit is low, output frame pulse FPo_OFF2.
7	FPOF1EN	FPo_OFF1 Enable When this bit is high, output frame pulse FPo_OFF1 is enabled. When this bit is low, output frame pulse FPo_OFF1 is in high impedance state.
6	FPOF0EN	FPo_OFF0 Enable When this bit is high, output frame pulse FPo_OFF0 is enabled. When this bit is low, output frame pulse FPo_OFF0 is in high impedance state.
5	Unused	Reserved In normal functional mode, these bits MUST be set to zero.
4	Unused	Reserved In normal functional mode, these bits MUST be set to zero.
3	CKOFPO3 EN	CKo3 and FPo3 Enable When this bit is high, output clock CKo3 and output frame pulse FPo3 are enabled. When this bit is low, CKo3 and FPo3 are in high impedance state.
2	CKOFPO2 EN	CKo2 and FPo2 Enable When this bit is high, output clock CKo2 and output frame pulse FPo2 are enabled. When this bit is low, CKo2 and FPo2 are in high impedance state.
1	CKOFPO1 EN	CKo1 and FPo1 Enable When this bit is high, output clock CKo1 and output frame pulse FPo1 are enabled. When this bit is low, CKo1 and FPo1 are in high impedance state.
0	CKOFPO0 EN	CKo0 and FPo0 Enable When this bit is high, output clock CKo0 and output frame pulse FPo0 are enabled. When this bit is low, CKo0 and FPo0 are in high impedance state.

Table 16 - Output Clock and Frame Pulse Control Register (OCFCR) Bits

External Reset Va			lress: 0	004 _H											
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	CKO FPO3 SEL1	CKO FPO3 SEL0	CKO3 P	FPO3 P	FPO3 POS	CKO2 P	FPO2 P	FPO2 POS	CKO1 P	FPO1 P	FPO1 POS	CKO0 P	FPO0 P	FPO0 POS
Bit		Name							Descri	ption					
15 - 14		Unused		Reserve n norma		onal m	ode, the	ese bits	MUST	be set	to zero).			
13 - 12		KOFPC SEL1 - (Output Selectio		(CKo3)	Frequ	iency a	and Ou	ıtput F	rame	Pulse	(FPo3)	Pulse	Cycle
						CKOI SEL	FPO3 1 - 0		FPo3		C	Ko3			
						0			244 ns			96 MHz			
						1			122 ns 61 ns			92 MHz 84 MHz			
						1			30 ns			68 MHz			
11	1	CKO3P	\ k	Output (When the coundary rame bo	is bit y. Whe	is low, n this l	the o	utput c	lock C						
10		FPO3P	١	Dutput I Vhen thi Vhen thi	s bit is	low, the	e outpu	t frame	pulse F	Po3 h					
9	F	PO3PO	١	Dutput I When thi When thi	s bit is	low, FF	o3 stra	addles f	rame b).
8		CKO2P	\ k	Output (When the coundary rame both	is bit y. Whe	is low, n this l	the o	utput c	lock C						
7		FPO2P	١	Dutput I When thi When thi	s bit is	low, the	e outpu	t frame	pulse F	Po2 h					
6	F	PO2PO	١	Dutput I When thi When thi	s bit is	low, FF	o2 stra	addles f	rame b).

Table 17 - Output Clock and Frame Pulse Selection Register (OCFSR) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	CKO FPO3 SEL1	CK(FPO SEL)3 P	FPO3 P	FPO3 POS	CKO2 P	FPO2 P	FPO2 POS	CKO1 P	FPO1 P	FPO1 POS	CKO0 P	FPO0 P	FPO0 POS
				•											
Bit		Name							Descri	ption					
5		CKO1F		Output (When the boundary frame bo	nis bit ُ y. Whe	is low, n this l	the o	utput c	lock C						
4		FPO1P		Output If When thi When thi	is bit is	low, the	outpu	t frame	pulse F	Po1 h					
3	F	PO1PC	S	Output If When thi When thi	is bit is	low, FF	o1 stra	iddles f	rame b).
2		CKO0F	,	Output (When the boundary frame bo	nis bit ُ y. Whe	is low, n this l	the o	utput c	lock C						
		FPO0P		Output If When thi When thi	is bit is	low, the	outpu	t frame	pulse F	Po0 ha		_		•	
1							FPo0)								

Table 17 - Output Clock and Frame Pulse Selection Register (OCFSR) Bits (continued)

0 - 255

FPO2P

FP02P0S

	l Read/Wri ⁄alue: 0000		ess: 0	005 _H - 00	007 _H									
15	14 13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0 0	0	0	0	FOF[n] OFF7	FOF[n] OFF6	FOF[n] OFF5	FOF[n] OFF4	FOF[n] OFF3	FOF[n] OFF2	FOF[n] OFF1	FOF[n] OFF0	FOF[C1	
	1													
Bit	Na	ame						D	escripti	ion				
15 - 10	Uni	used		Reserv	ed. In i	normal fu	ınctiona	ıl mode,	these b	oits MUS	T be se	t to zero	٥.	
9 - 2	FOF[n]	OFF7 -		The bin	ary val	Channel ue of the channel	se bits							me bound
1 - 0	FOF[r	n]C1 - (0	FPo_O	FF[n] (Control b	oits							
				FOF[r 1-0		ata Rate (Mbps)		Po_OFF e Cycle \		Peri	OFF7 - 0 nitted el Offset	Cont		Position Control
				00		2.048	one 4	.096 MH	z clock	0	- 31	FPO	0P	FPO0POS
				01		4.096	one 8	.192 MH:	z clock	0	- 63	FPO	1P	FPO1POS
				10		8.192	one 1 clock	6.384 MI	Ηz	0 -	127	FPO	2P	FPO2POS

Note: [n] denotes output offset frame pulse from 0 to 2.

Table 18 - FPo_OFF[n] Register (FPo_OFF[n]) Bits

clock

16.384

one 16.384 MHz

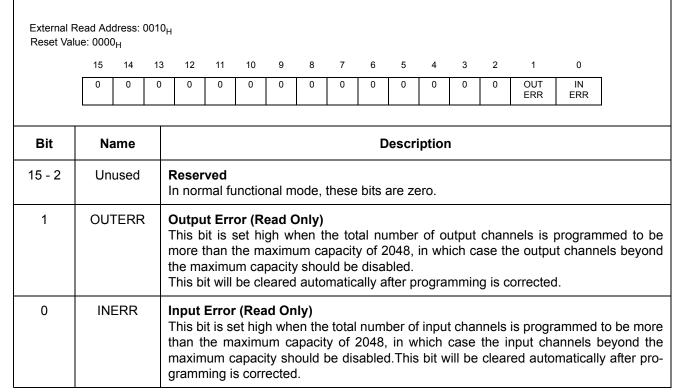


Table 19 - Internal Flag Register (IFR) Bits - Read Only

	l Read Ado alue: 0000		0011 _H													
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
BEF F15		BER F13	BER F12	BER F11	BER F10	BER F9	BER F8	BER F7	BER F6	BER F5	BER F4	BER F3	BER F2	BER F1	BER F0	
Bit	Nan	ne						1	Descri	ption						
15 - 0	BER	-[n]	If BE	RF[n] i		, it indi						Ū	\	-	n]) is no	
Note: [n] de	notes inpu	t stream	from 0	- 15.												

Table 20 - BER Error Flag Register 0 (BERFR0) Blts - Read Only

		Read/Writ		ess: 0001	12 _H											
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BER F31	BER F30	BER F29	BER F28	BER F27	BER F26	BER F25	BER F24	BER F23	BER F22	BER F21	BER F20	BER F19	BER F18	BER F17	BER F16
Bit	t	Nam	ne						[Descri	ption					

Table 21 - BER Error Flag Register 1 (BERFR1) Bits - Read Only

	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BER L15	BER L14	BER L13	BER L12	BER L11	BER L10	BER L9	BER L8	BER L7	BER L6	BER L5	BER L4	BER L3	BER L2	BER L1	BER L0
Bi	t	Nam	ne							Descri	ption					
				D-D	Pagai	var I a	ck[n]									

Table 22 - BER Receiver Lock Register 0 (BERLR0) Bits - Read Only

		Read Add alue: 0000 _l		0014 _H												
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	BER L31	BER L30	BER L29	BER L28	BER L27	BER L26	BER L25	BER L24	BER L23	BER L22	BER L21	BER L20	BER L19	BER L18	BER L17	BER L16
Bit	t	Nam	16						[Descri	ption					
15 -	0	BERL	_[n]			s high,	it indi	cates t			eiver o	_	i] is loc is not			

Table 23 - BER Receiver Lock Register 1 (BERLR1) Bits - Read Only

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	STIN[n] BD2	STIN[n] BD1	STIN[n] BD0	STIN[n] SMP1	STIN[n] SMP0	STIN[n] DR3	STIN[n] DR2	STIN[n] DR1	STIN[n] DR0
Bi	Bit Name 15 - 9 Unused									D	escripti	on			
15 -	15 - 9 Unused						Reserve n normal	d I function	al mode	, these b	its MUS	r be set	to zero.		
8 -	8 - 6 STIN[n]BD2 - 0					nput Str Γhe binaι	ream[n] I		•	ro to the	numbor	of bito th			
	5 - 4 STIN[n							layed rel							
5 -	4	S	ΓIN[n]SM	P1 - (١	vill be de		ative to	FPi. The	maximu	m value			
5 -	4	S	ΓIN[n]SM	P1 - (١	vill be de	ta Samp	ative to	FPi. The nt Selec Sar 3 Mbps, 4	maximu tion Bits npling Po	m value int	is 7. Zer	Sampl (16.3	
5 -	4	S	ΓΙΝ[n]SM	P1 - (١	vill be de	ta Samp	ative to	FPi. The nt Selec Sar 3 Mbps, 4	maximu tion Bits npling Po .096 Mbp	m value int	is 7. Zer	Sampl (16.33	no dela ling Point 84 Mbps
5 -	4	S	TIN[n]SM	P1 - (١	vill be de	elayed relayed relayed for the Samp	ative to	FPi. The nt Selec Sar 3 Mbps, 4	maximu tion Bits npling Po .096 Mbp streams)	m value int	is 7. Zer	Sampl (16.33	ing Point 84 Mbps eams)
5 -	4	S	ΓΙΝ[n]SM	P1 - (١	vill be de nput Da STIN[n]S	ta Samp	ative to	FPi. The nt Selec Sar 3 Mbps, 4	maximu tion Bits npling Po .096 Mbp streams) 3/4 point	m value int	is 7. Zer	Sampl (16.3a stre	ing Point 84 Mbps eams)

Table 24 - Stream Input Control Register 0 - 31 (SICR0 - 31) Bits

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15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	0	0	0	STIN[n] BD2	STIN[n] BD1	STIN[n] BD0	STIN[n] SMP1	STIN[n] SMP0	STIN[n] DR3	STIN[n] DR2	STIN[n] DR1	STIN[n] DR0
Bi	Bit Name 3 - 0 STIN[n]DR3 - 0									D	escripti	on			
3 -	0	S	TIN[n]DR	R3 - 0	ı	nput Da	ta Rate	Selectio	n Bits:					
									STIN[n][DR3-0		Data Rate	}		
								Ī	000	0	Stre	eam Unus	sed	1	
									000	1	2.	.048 Mbp	s	1	
									001	0	4.	.096 Mbp	s		
									001	1	8.	.192 Mbp	S		
									010	0	16	.384 Mbp	os		
									0101 -	1111	F	Reserved			

Table 24 - Stream Input Control Register 0 - 31 (SICR0 - 31) Bits (continued)

	rnai Re et Valu			dress: 012	0 _H - 013F _H										
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	STIN[n] Q3C2	STIN[n] Q3C1	STIN[n] Q3C0	STIN[n] Q2C2	STIN[n] Q2C1	STIN[n] Q2C0	STIN[n] Q1C2	STIN[n] Q1C1	STIN[n] Q1C0	STIN[n] Q0C2	STIN[n] Q0C1	STIN[n] Q0C0
Ві	it		l	Name						Descr	ription				
15 -	12		L	Jnused		Reserve n norma		nal mod	de, thes	e bits M	I UST be	set to	zero.		
11 -	- 9	S	TIN[[n]Q3C2	T a	Quadran These th s Ch24 .096 Mb	ree bits to 31, C	are use th48 to	ed to coi 63, Ch9	ntrol ST 6 to 12	7 and C	h192 to	255 for	the 2.0	
							STIN[n 2-0	-			Ope	ration			
							0x	х			normal	operatio	n		
							10	0	LS	B of eac	ch chann	el is rep	laced by	"0"	
							10	1	LS	B of eac	ch chann	el is rep	laced by	"1"	
							11	0	MS	SB of ea	ch chanr	nel is rep	laced by	"0"	
							11	1	MS	SB of ea	ch chanr	nel is rep	laced by	"1"	
8 -	6	S	TINI	[n]Q2C2	T a	Quadran hese th s Ch16 .096 Mb	ree bits to 23, 0	are use Ch32 to	ed to coi 47, Che	ntrol ST 64 to 95	and C	h128 to	191 for	the 2.0	
								N[n]Q2C 2-0			Ope	ration			
								0xx			normal	operatio	n		
								100	LS	BB of eac	ch chann	el is rep	laced by	"0"	
								101	LS	BB of eac	ch chann	el is rep	laced by	"1"	
								110	M	SB of ea	ch chanr	nel is rep	laced by	"0"	
					1			111				nel is rep			

Table 25 - Stream Input Quadrant Frame Register 0 - 31 (SIQFR0 - 31) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
0	0	0	0	STIN[n] Q3C2	STIN[n] Q3C1	STIN[n] Q3C0	STIN[n] Q2C2	STIN[n] Q2C1	STIN[n] Q2C0	STIN[n] Q1C2	STIN[n] Q1C1	STIN[n] Q1C0	STIN[n] Q0C2	STIN[n] Q0C1	STIN[n] Q0C0
Bi	it		ļ	Name						Desci	ription				
5 -	3	S	TIN[n]Q1C2	th a	s Ch8 t	ee bits o 15, C	are use h16 to	d to cor 31, Chi s, and 1	t s ntrol STi 32 to 63 16.384 N	and College and Co	h64 to odes res	127 for	the 2.0	
							31	2-0			·	eration			
								0xx				operatio			
								100		SB of ea		•	•		
								101		SB of ea					
								110		ISB of ea					
								111	M	ISB of ea	ich chan	nel is rep	placed by	′ "1"	
2 -	0	S	TIN[n]Q0C2	T a	s Ch0	ree bits to 7, C	are use	ed to co 15, Ch	t s ntrol ST 0 to 31 16.384 N	and C	Ch0 to	63 for	the 2.0	
							STI	N[n]Q0C	2-0		Оре	eration			
								0xx			normal	operation	n		
								100	L	SB of ea	ich chan	nel is rep	olaced by	/ "O"	
								101	L	SB of ea	ich chan	nel is rep	olaced by	/ "1"	
								110	N	ISB of ea	ach chan	nel is re	placed by	y "0"	
							-	111		ISB of ea			-1	. "4"	

Table 25 - Stream Input Quadrant Frame Register 0 - 31 (SIQFR0 - 31) Bits (continued)

External Read/Write Address: $0200_{\rm H}$ - $021F_{\rm H}$ Reset Value: 0000_H 13 11 10 8 7 5 3 0 STOHZ STOHZ STOHZ STO[n] FA1 STO[n] AD0 STO[n] DR3 0 0 STO[n] FA0 STO[n] AD2 STO[n] AD1 STO[n] DR2 STO[n] DR1 STO[n] DR0 0 0 [n]A2 [n]A1 [n]A0 Bit Name Description 15 - 12 Unused Reserved In normal functional mode, these bits **MUST** be set to zero. 11 - 9 STOHZ[n]A2 - 0 STOHZ Additional Advancement Bits Additional Advancement Additional Advancement (Valid only for STio0-15) STOHZ[n]A2-0 (2.048 Mbps, 4.096 Mbps, (16.384 Mbps streams) 8.192 Mbps) 000 0 bit 0 bit 001 1/4 bit 2/4 bit 010 2/4 bit 4/4 bit 011 3/4 bit Reserved 100 4/4 bit 101-111 Reserved 8 - 7 STO[n]FA1 - 0 Output Stream[n] Fractional Advancement Bits Advancement Advancement STO[n]FA1-0 (2.048 Mbps, 4.096 Mbps, (16.384 Mbps streams) 8.192 Mbps streams) 00 0 01 1/4 bit 2/4 10 2/4 bit Reserved 11 3/4 bit 6 - 4 STO[n]AD2 - 0 Output Stream[n] Bit Advancement Selection Bits The binary value of these bits refers to the number of bits that the output stream is to be advanced relative to FPo. The maximum value is 7. Zero means no advancement. 3 - 0 STO[n]DR3 - 0 **Output Data Rate Selection Bits** Data Rate STIN[n]DR3 - 0 0000 disabled: STio HiZ (STOHZ driven high) 0001 2.048 Mbps 0010 4.096 Mbps 0011 8.192 Mbps 0100 16.384 Mbps 0101 - 1111 Reserved Note: [n] denotes output stream from 0 - 31.

Table 26 - Stream Output Control Register 0 - 31 (SOCR0 - 31) Bits

		l Read alue: 0		ddres	s: 0300 _F	_I - 031F	Н									
	15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
	0	0	0	0	0	0	0	0	ST[n] BRS7	ST[n] BRS6	ST[n] BRS5	ST[n] BRS4	ST[n] BRS3	ST[n] BRS2	ST[n] BRS1	ST[n] BRS0
Bi	it		Name							D	escript	ion				
15 -	- 8	U	nused	t	Reser In nor		nction	nal mo	de, thes	se bits N	MUST b	e set to	zero.			
7 -	0		ST[n] RS7 -	0		inary \	/alue		re Start se bits r		the inp	out char	inel in v	vhich th	e BER	data staı

Table 27 - BER Receiver Start Register [n] (BRSR[n]) Bits

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0	
0	0	0	0	0	0	0	ST[n] BL8	ST[n] BL7	ST[n] BL6	ST[n] BL5	ST[n] BL4	ST[n] BL3	ST[n] BL2	ST[n] BL1	ST[n] BL0	
Bit		Name	•		Description											
15 - 9	1	Unuse	d													
8 - 0		ST[n] BL8 -		The bound to recommend to 256 fe	Reserved In normal functional mode, these bits MUST be set to zero. Iteram[n] BER Length Bits The binary value of these bits refers to the number of consecutive channels expected to receive the BER pattern. The maximum number of BER channels is 32, 64, 128 and 56 for the data rates of 2.048 Mbps, 4.096 Mbps, 8.192 Mbps and 16.384 Mbps respectively. The minimum number of BER channels is 1. If these bits are set to zero,											

Table 28 - BER Receiver Length Register [n] (BRLR[n]) Bits

ZL50020 Data Sheet

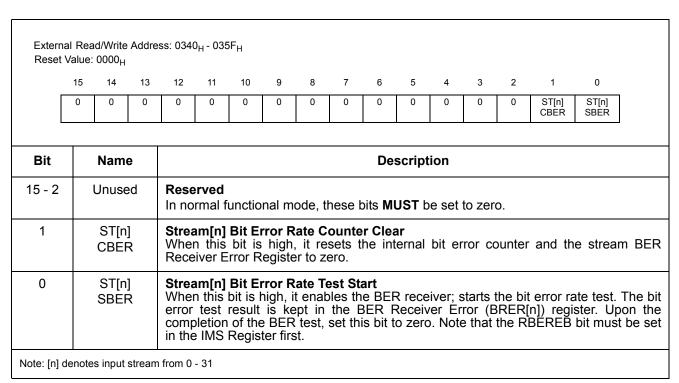


Table 29 - BER Receiver Control Register [n] (BRCR[n]) Bits

External Read Address: 0360 _H - 037F _H Reset Value: 0000 _H															
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
ST[n] BC15	ST[n] BC14	ST[n] BC13	ST[n] BC12	ST[n] BC11	ST[n] BC10	ST[n] BC9	ST[n] BC8	ST[n] BC7	ST[n] BC6	ST[n] BC5	ST[n] BC4	ST[n] BC3	ST[n] BC2	ST[n] BC1	ST[n] BC0
Bit Name Description															
15 - 0		ST[n] C15 - 0	Th	Stream[n] BER Count Bits (Read Only) The binary value of these bits refers to the bit error counts. When it reaches its maximum value of 0xFFFF, the value will be held and will not rollover.											

Table 30 - BER Receiver Error Register [n] (BRER[n]) Bits - Read Only

20.0 **Memory**

20.1 **Memory Address Mappings**

When A13 is high, the data or connection memory can be accessed by the microprocessor port. Bit 1 - 0 in the Control Register determine the access to the data or connection memory (CM_L or CM_H).

MSB (Note 1)	Stream Address (St0 - 31)										nnel A (Ch0 -	ddres: 255)	S		
A13	A12	A11	A10	А9	A8	Stream [n]	Α7	A6	A5	A4	А3	A2	A 1	A0	Channel [n]
1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1 1	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	0 0 0 0 0 0 0 0 1	0 0 0 0 1 1 1 1 1 0 0	0 0 0 1 1 1 0 0 0 1 1 1 0 0 0 0 0 0 0 0	0 1 0 1 0 1 0 0 1 0 0 0 0 0 0 0 0 1 1	Stream 0 Stream 1 Stream 2 Stream 3 Stream 4 Stream 5 Stream 6 Stream 7 Stream 8 Stream 14 Stream 15	0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0 0	0 0 0 0 0 0 0	0 0 0 0 0 1 1 1	0 0 1 1 0 0	0 0 0	0 0 0	0 0 1 1 0 0	0 1	Ch 0 Ch 1 Ch 30 Ch 31 (Note 2) Ch 32 Ch 33 Ch 62 Ch 63 (Note 3)
1	1	1	1	1		Stream 31	1 1	1 1	1 1	1 1	1 1	1 1	1 1	0 1	Ch 254 Ch 255 (Note 5)

- Notes:

 1. A13 must be high for access to data and connection memory positions. A13 must be low to access internal registers.

 2. Channels 0 to 31 are used when serial stream is at 2.048 Mbps.

 3. Channels 0 to 63 are used when serial stream is at 4.096 Mbps.

 4. Channels 0 to 127 are used when serial stream is at 8.192 Mbps.

Table 31 - Address Map for Memory Locations (A13 = 1)

20.2 Connection Memory Low (CM_L) Bit Assignment

When the CMM bit (bit 0) in the connection memory low is zero, the per-channel transmission is set to the normal channel-switching. The connection memory low bit assignment for the channel transmission mode is shown in Table 32 on page 57.

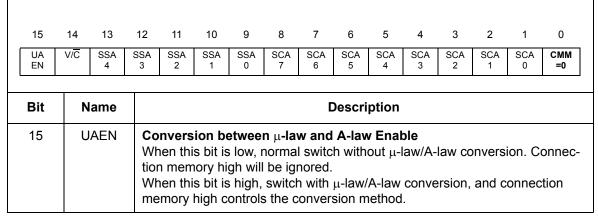


Table 32 - Connection Memory Low (CM_L) Bit Assignment when CMM = 0

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UA EN	V/C	SSA 4	SSA 3	SSA 2	SSA 1	SSA 0	SCA 7	SCA 6	SCA 5	SCA 4	SCA 3	SCA 2	SCA 1	SCA 0	CMM =0
Bit	N	ame						[Descri	ption					
14	`	V/C	Wh sta Wh	hen this bit is low, the output data for this channel will be taken from conant delay memory. hen this bit is set to high, the output data for this channel will be taken from this bit is set to high, the output data for this channel will be taken from triable delay memory. Note that VAREN must be set in Control Register st.											
13 - 9	SS	A4 - 0		urce S e bina				bits r	eprese	ents th	e inpu	ıt strea	am nur	mber.	
8 - 1	SC	A7 - 0		The binary value of these 5 bits represents the input stream number. Source Channel Address The binary value of these 8 bits represents the input channel number.											
0	CM	1M = 0	If th	Connection Memory Mode = 0 If this is low, the connection memory is in the normal switching mode. Bit13 - 1 are the source stream number and channel number.											
Note: For	prope	er μ-law	/A-law	conver	sion, tl	ne CM_	H bits	should	be set b	pefore I	3it 15 (I	UAEN b	oit) is s	et to hiç	gh.

Table 32 - Connection Memory Low (CM_L) Bit Assignment when CMM = 0

When CMM is one, the device is programmed to perform one of the special per-channel transmission modes. Bits PCC0 and PCC1 from connection memory are used to select the per-channel tristate, message or BER test mode as shown in Table 33 on page 58.

15 UA EN	14	13	12	11	10 MSG 7	9 MSG 6	8 MSG 5	7 MSG 4	6 MSG 3	5 MSG 2	4 MSG 1	3 MSG 0	2 PCC 1	1 PCC 0	0 CMM =1
Bit	ı	Nam	е						De	scripti	ion				
15	l	JAE	N	Wh tion Wh	Conversion between μ -law and A-law Enable (Message mode only) When this bit is low, message mode has no μ -law/A-law conversion. Connection memory high will be ignored. When this bit is high, message mode has μ -law/A-law conversion, and connection memory high controls the conversion method.										
14 - 11	U	Jnus	ed	Reserved In normal functional mode, these bits MUST be set to zero.											
10 - 3	MS	SG7	- 0	Message Data Bits 8-bit data for the message mode. Not used in the per-channel tristate and BER test modes.											

Table 33 - Connection Memory Low (CM_L) Bit Assignment when CMM = 1

4.5		40	40	44	40			_						_	
15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	0
UA EN	0	0	0	0	MSG 7	MSG 6	MSG 5	MSG 4	MSG 3	MSG 2	MSG 1	MSG 0	PCC 1	PCC 0	CMM =1
Bit		Nam	е						De	scripti	on				
2 - 1	Р	CC1	- 0		Per-Channel Control Bits These two bits control the corresponding entry's value on the STio stream.										
							PC C1	PC C0	Channel Output Mode Per Channel Tristate						
							0	0	F	Per Cha	nnel Tr	istate			
							0	1		Mess	age Mo	de			
							1	0		BER	Test Mo	ode			
							1	1		Re	eserved				
0	С	MM :	M = 1 Connection Memory Mode = 1 If this is high, the connection memory is in the per-channel control mode which is per-channel tristate, per-channel message mode or per-channel BER mode.												
Note: For p	orope	r μ-la\	w/A-la	w con	version,	the CM	_H bits s	should be	e set bef	ore Bit 1	5 (UAEI	N bit) is s	set to hig	gh.	

Table 33 - Connection Memory Low (CM_L) Bit Assignment when CMM = 1

20.3 Connection Memory High (CM_H) Bit Assignment

Connection memory high provides the detailed information required for μ -law and A-law conversion. ICL and OCL bits describe the Input Coding Law and the Output Coding Law, respectively. They are used to select the expected PCM coding laws for the connection, on the TDM inputs, and on the TDM outputs. The \overline{V}/D bit is used to select the class of coding law. If the \overline{V}/D bit is cleared (to select a voice connection), the ICL and OCL bits select between A-law and μ -law specifications related to G.711 voice coding. If the \overline{V}/D bit is set (to select a data connection), the ICL and OCL bits select between various bit inverting protocols. These coding laws are illustrated in the following table. If the ICL is different than the OCL, all data bytes passing through the switch on that particular connection are translated between the indicated laws. If the ICL and the OCL are the same, no coding law translation is performed. The ICL, the OCL bits and \overline{V}/D bit only have an effect on PCM code translations for constant delay connections, variable delay connections and per-channel message mode.

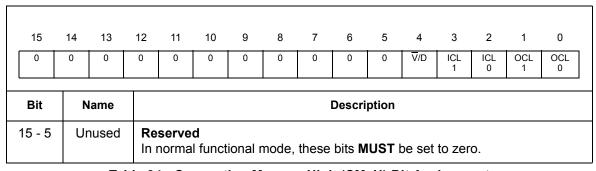


Table 34 - Connection Memory High (CM_H) Bit Assignment

ZL50020 Data Sheet

15	14	13	12	11	10	9	8	7	6	5	4	3	2	1	C
0	0	0	0	0	0	0	0	0	0	0	∇/D	ICL 1	ICL 0	OCL 1	000
Bit	N	lame							Descri	ption					
4	;	V/D	Wh	nen thi	ata Co is bit is is bit is	low, t									
3 - 2	IC	L1 - 0	Inp	out Co	ding l	_aw.									
				ı	ICL1-0					Codin					
					F	or Voice	•)	For Da	ata (V/I		1)		
					00			T.ITU A				No co	de		
					01		CCITT	Γ.ITU μ	ı-law			ABI			
					10		A-la	w w/o A	ABI		In	verted	ABI		
					11	μ	ı-law w. In	o Mag versior			All	Bits Inv	verted		
1 - 0	00	CL1 - 0	Ou	tput (Coding	 յ Law	,								
									Outpu	ıt Codi	ng Law	1			
					OCL1-		For Voi	ce (V/D) bit = (0)	For Da	ıta (V/C) bit =	1)	
					00		CCIT	T.ITU	A-law			No coo	de		
					01		CCIT	T.ITU	μ-law			ABI			
					10		A-la	aw w/o	ABI		In	verted	ABI		
					11		μ-law v	v/o Ma nversio		е	All E	3its Inv	erted		

Table 34 - Connection Memory High (CM_H) Bit Assignment

Note 2: Refer to G.711 standard for detail information of different laws.

21.0 DC Parameters

Absolute Maximum Ratings*

	Parameter	Symbol	Min.	Max.	Units
1	I/O Supply Voltage	V _{DD_IO}	-0.5	5.0	V
2	Core Supply Voltage	V _{DD_CORE}	-0.5	2.5	V
3	Input Voltage	V _{I_3V}	-0.5	V _{DD} + 0.5	V
4	Input Voltage (5 V-tolerant inputs)	V _{I_5V}	-0.5	7.0	V
5	Continuous Current at Digital Outputs	Io		15	mA
6	Package Power Dissipation	P _D		1.5	W
7	Storage Temperature	T _S	- 55	+125	°C

^{*} Exceeding these values may cause permanent damage. Functional operation under these conditions is not implied.

$\textbf{Recommended Operating Conditions -} \ \textit{Voltages are with respect to ground (V_{SS}) unless otherwise stated.}$

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units
1	Operating Temperature	T _{OP}	-40	25	+85	°C
2	Positive Supply	V_{DD_IO}	3.0	3.3	3.6	V
3	Positive Supply	V _{DD_CORE}	1.71	1.8	1.89	V
4	Input Voltage	V _I	0	3.3	V_{DD_IO}	V
5	Input Voltage on 5 V-Tolerant Inputs	V _{I_5V}	0	5.0	5.5	V

[‡] Typical figures are at 25°C and are for design aid only: not guaranteed and not subject to production testing.

DC Electrical Characteristics[†] - Voltages are with respect to ground (V_{ss}) unless otherwise stated.

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions
1	Supply Current - V _{DD_CORE}	I _{DD_CORE}			120	mA	
2	Supply Current - V _{DD_IO}	I _{DD_IO}			70	mA	C _L =30pF
3	Input High Voltage	V _{IH}	2.0			V	
4	Input Low Voltage	V _{IL}			0.8	V	
5	Input Leakage (input pins) Input Leakage (bi-directional pins)	I _{IL} I _{BL}			5 5	μ Α μ Α	0≤ <v<sub>IN≤V_{DD_IO} See Note 1</v<sub>
6	Weak Pullup Current	I _{PU}		-33		μΑ	Input at 0V
7	Weak Pulldown Current	I _{PD}		33		μΑ	Input at V _{DD_IO}
8	Input Pin Capacitance	C _I		3		pF	
9	Output High Voltage	V _{OH}	2.4			V	I _{OH} = 8 mA
10	Output Low Voltage	V _{OL}			0.4	V	I _{OL} = 8 mA
11	Output High Impedance Leakage	I _{OZ}			5	μΑ	0 < V < V _{DD}
12	Output Pin Capacitance	C _O		5	10	pF	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

Note 1: Maximum leakage on pins (output or I/O pins in high impedance state) is over an applied voltage (V_{IN}).

22.0 AC Parameters

$\textbf{AC Electrical Characteristics}^{\dagger} \textbf{ - Timing Parameter Measurement Voltage Levels}$

	Characteristics	Sym.	Level	Units	Conditions
1	CMOS Threshold	V _{CT}	0.5 V _{DD_IO}	V	
2	Rise/Fall Threshold Voltage High	V_{HM}	0.7 V _{DD_IO}	V	
3	Rise/Fall Threshold Voltage Low	V_{LM}	0.3 V _{DD_IO}	V	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

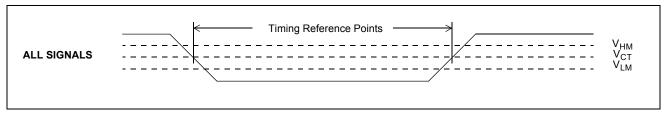


Figure 19 - Timing Parameter Measurement Voltage Levels

AC Electrical Characteristics[†] - Motorola Non-Multiplexed Bus Mode - Read Access

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions ²
1	CS de-asserted time	t _{CSD}	15			ns	
2	DS de-asserted time	t _{DSD}	15			ns	
3	CS setup to DS falling	t _{CSS}	0			ns	
4	R/W setup to DS falling	t _{RWS}	10			ns	
5	Address setup to DS falling	t _{AS}	5			ns	
6	CS hold after DS rising	t _{CSH}	0			ns	
7	R/W hold after DS rising	t _{RWH}	0			ns	
8	Address hold after DS rising	t _{AH}	0			ns	
9	Data setup to DTA Low	t _{DS}	8			ns	C _L = 50 pF
10	Data hold after DS rising	t _{DHZ}	7			ns	$C_L = 50 \text{ pF}, R_L = 1 \text{ K}$ (Note 1)
11	Acknowledgement delay time. From DS low to DTA low: Registers Memory	t _{AKD}			75 185	ns ns	C _L = 50 pF C _L = 50 pF
12	Acknowledgement hold time. From DS high to DTA high	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
13	DTA drive high to HiZ	t _{AKZ}			8	ns	

High impedance is measured by pulling to the appropriate rail with R₁, with timing corrected to cancel time taken to discharge C_L

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

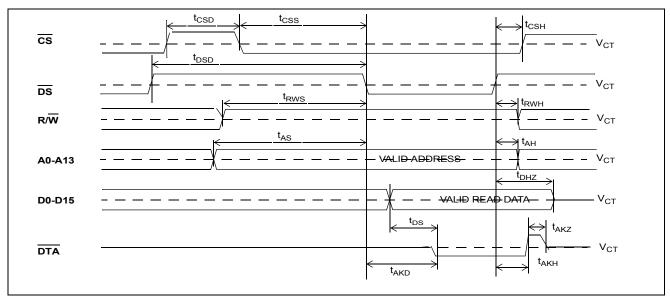


Figure 20 - Motorola Non-Multiplexed Bus Timing - Read Access

A delay of 500 μ s to 2 ms (see Section 13.2 on page 33) must be applied before the first microprocessor access is performed after the RESET pin is set high. Note 2:

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - Motorola Non-Multiplexed Bus Mode - Write Access

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions ²
1	CS de-asserted time	t _{CSD}	15			ns	
2	DS de-asserted time	t _{DSD}	15			ns	
3	CS setup to DS falling	t _{CSS}	0			ns	
4	R/W setup to DS falling	t _{RWS}	10			ns	
5	Address setup to DS falling	t _{AS}	5			ns	
6	Data setup to DS falling	t _{DS}	0			ns	C _L = 50 pF
7	CS hold after DS rising	t _{CSH}	0			ns	
8	R/W hold after DS rising	t _{RWH}	0			ns	
9	Address hold after DS rising	t _{AH}	0			ns	
10	Data hold from DS rising	t _{DH}	5			ns	$C_L = 50 \text{ pF}, R_L = 1 \text{ K}$ (Note 1)
11	Acknowledgement delay time. From DS low to DTA low: Registers Memory	t _{AKD}			55 150	ns ns	C _L = 50 pF C _I = 50 pF
12	Acknowledgement hold time. From DS high to DTA high	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
13	DTA drive high to HiZ	t _{AKZ}			8	ns	

Note 1: High impedance is measured by pulling to the appropriate rail with R_L, with timing corrected to cancel time taken to discharge C_L

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

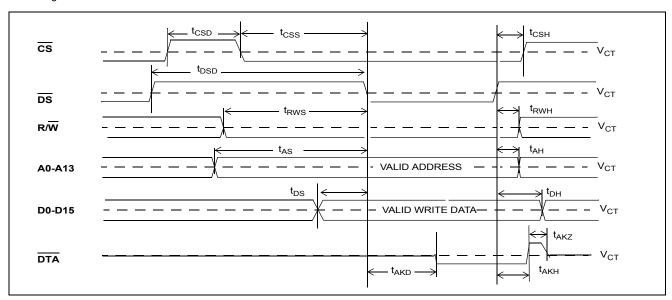


Figure 21 - Motorola Non-Multiplexed Bus Timing - Write Access

A delay of 500 μs to 2 ms (see Section 13.2 on page 33) must be applied before the first microprocessor access is performed after the RESET pin is set high. Note 2:

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - Intel Non-Multiplexed Bus Mode - Read Access

	Characteristics	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions ²
1	CS de-asserted time	t _{CSD}	15			ns	
2	RD setup to CS falling	t _{RS}	10			ns	
3	WR setup to CS falling	t _{WS}	10			ns	
4	Address setup to CS falling	t _{AS}	5			ns	
5	RD hold after CS rising	t _{RH}	0			ns	
6	WR hold after CS rising	t _{WH}	0			ns	
7	Address hold after CS rising	t _{AH}	0			ns	
8	Data setup to RDY high	t _{DS}	8			ns	C _L = 50 pF
9	Data hold after CS rising	t _{CSZ}	7			ns	C _L = 50 pF, R _L = 1 K (Note 1)
10	Acknowledgement delay time. From CS low to RDY high: Registers Memory	t _{AKD}			175 185	ns ns	C _L = 50 pF C _L = 50 pF
11	Acknowledgement hold time. From CS high to RDY low	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
12	RDY drive low to HiZ	t _{AKZ}			8	ns	

Note 1: High impedance is measured by pulling to the appropriate rail with R_L , with timing corrected to cancel time taken to discharge C_L .

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

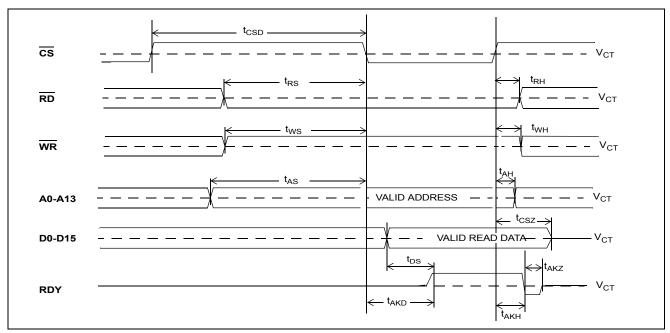


Figure 22 - Intel Non-Multiplexed Bus Timing - Read Access

Note 2: A delay of 500 μ s to 2 ms (see Section 13.2 on page 33) must be applied before the first microprocessor access is performed after the RESET pin is set high.

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - Intel Non-Multiplexed Bus Mode - Write Access

	Characteristics	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions ²
1	CS de-asserted time	t _{CSD}	15			ns	
2	WR setup to CS falling	t _{WS}	10			ns	
3	RD setup to CS falling	t _{RS}	10			ns	
4	Address setup to CS falling	t _{AS}	5			ns	
5	Data setup to CS falling	t _{DS}	0			ns	C _L = 50 pF
6	WR hold after CS rising	t _{WH}	0			ns	
7	RD hold after CS rising	t _{RH}	0			ns	
8	Address hold after CS rising	t _{AH}	10			ns	
9	Data hold after CS rising	t _{DH}	5			ns	$C_L = 50 \text{ pF}, R_L = 1 \text{ K}$ (Note 1)
10	Acknowledgement delay time. From CS low to RDY high: Registers Memory	t _{AKD}			55 150	ns ns	C _L = 50 pF C _L = 50 pF
11	Acknowledgement hold time. From CS high to RDY low	t _{AKH}	4		12	ns	C _L = 50 pF, R _L = 1 K (Note 1)
12	RDY drive low to HiZ	t _{AKZ}			8	ns	

High impedance is measured by pulling to the appropriate rail with R_L , with timing corrected to cancel time taken to discharge C_L . Note 1:

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

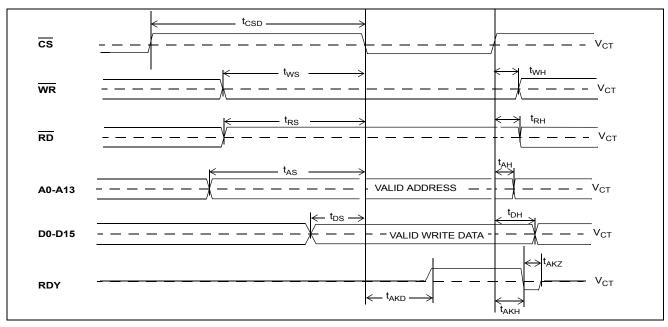


Figure 23 - Intel Non-Multiplexed Bus Timing - Write Access

Note 2: A delay of $500~\mu s$ to 2 ms (Section 13.2 on page 33) must be applied before the first microprocessor access is performed after the RESET pin is set high.

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - JTAG Test Port Timing

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	TCK Clock Period	t _{TCKP}	100			ns	
2	TCK Clock Pulse Width High	t _{TCKH}	20			ns	
3	TCK Clock Pulse Width Low	t _{TCKL}	20			ns	
4	TMS Set-up Time	t _{TMSS}	10			ns	
5	TMS Hold Time	t _{TMSH}	10			ns	
6	TDi Input Set-up Time	t _{TDIS}	20			ns	
7	TDi Input Hold Time	t _{TDIH}	60			ns	
8	TDo Output Delay	t _{TDOD}			30	ns	C _L = 30 pF
9	TRST pulse width	t _{TRSTW}	200			ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

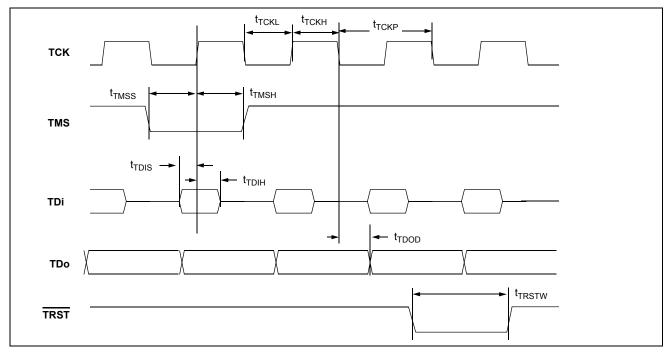


Figure 24 - JTAG Test Port Timing Diagram

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 00 (16.384 MHz)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	40	61	115	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	20			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	20			ns	
4	CKi Input Clock Period	t _{CKIP}	55	61	67	ns	
5	CKi Input Clock High Time	t _{CKIH}	27		34	ns	
6	CKi Input Clock Low Time	t _{CKIL}	27		34	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 01 (8.192 MHz)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	90	122	220	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	45			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	45			ns	
4	CKi Input Clock Period	t _{CKIP}	110	122	135	ns	
5	CKi Input Clock High Time	t _{CKIH}	55		69	ns	
6	CKi Input Clock Low Time	t _{CKIL}	55		69	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - FPi and CKi Timing when CKIN1-0 bits = 10 (4.096 MHz)

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPi Input Frame Pulse Width	t _{FPIW}	90	244	420	ns	
2	FPi Input Frame Pulse Setup Time	t _{FPIS}	110			ns	
3	FPi Input Frame Pulse Hold Time	t _{FPIH}	110			ns	
4	CKi Input Clock Period	t _{CKIP}	220	244	270	ns	
5	CKi Input Clock High Time	t _{CKIH}	110		135	ns	
6	CKi Input Clock Low Time	t _{CKIL}	110		135	ns	
7	CKi Input Clock Rise/Fall Time	t _r CKi, t _f CKi			3	ns	
8	CKi Input Clock Cycle to Cycle Variation	t _{CVC}	0		20	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

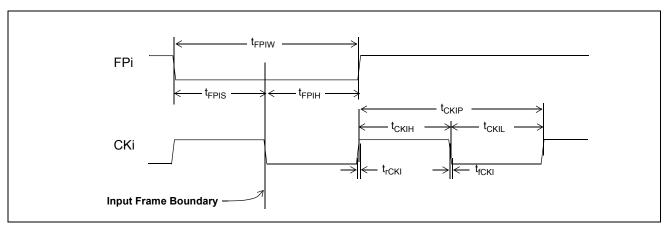


Figure 25 - Frame Pulse Input and Clock Input Timing Diagram (ST-BUS)

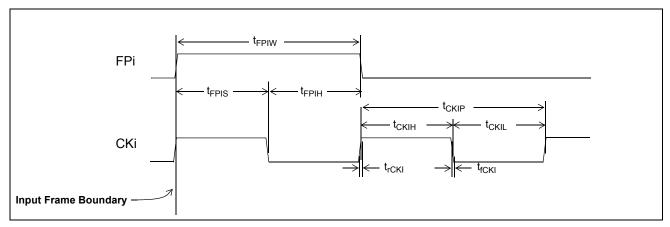


Figure 26 - Frame Pulse Input and Clock Input Timing Diagram (GCI-Bus)

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Input Timing

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	STi Setup Time						
	2.048 Mbps 4.096 Mbps 8.192 Mbps 16.384 Mbps	t _{SIS2} t _{SIS4} t _{SIS8} t _{SIS16}	5 5 5 5			ns ns ns ns	
2	STi Hold Time 2.048 Mbps 4.096 Mbps 8.192 Mbps 16.384 Mbps	t _{SIH2} t _{SIH4} t _{SIH8} t _{SIH16}	8 8 8			ns ns ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

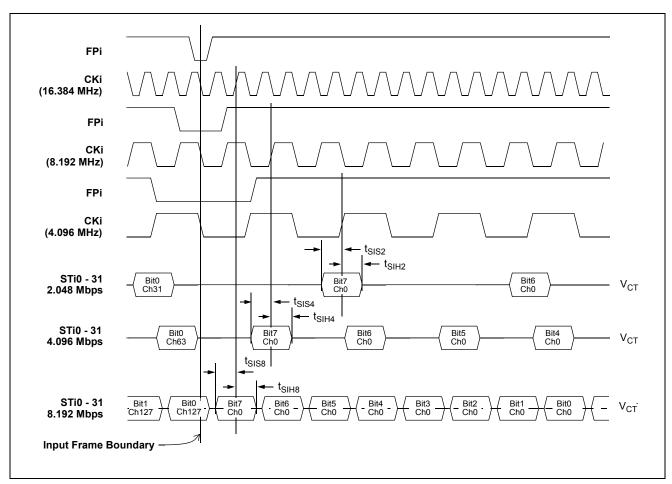


Figure 27 - ST-BUS Input Timing Diagram when Operated at 2, 4, 8 Mbps

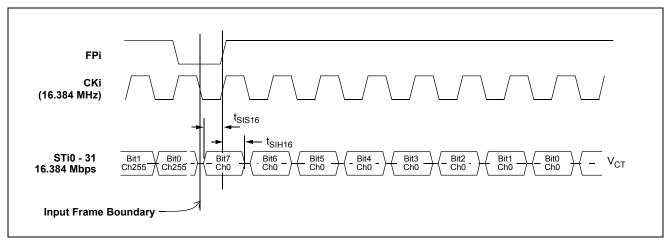


Figure 28 - ST-BUS Input Timing Diagram when Operated at 16 Mbps

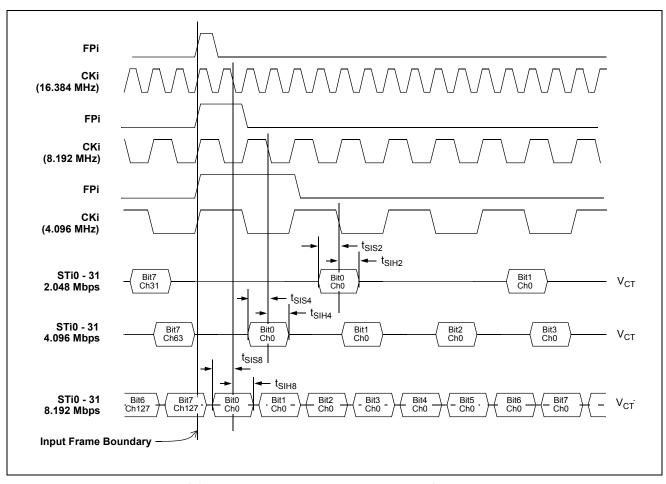


Figure 29 - GCI-Bus Input Timing Diagram when Operated at 2, 4, 8 Mbps

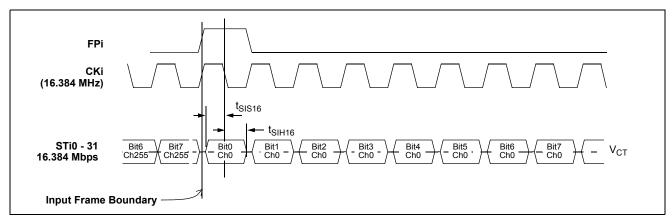


Figure 30 - GCI-Bus Input Timing Diagram when Operated at 16 Mbps

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Output Timing

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Test Conditions
1	STio Delay - Active to Active						C _L = 30 pF
	@2.048 Mbps @4.096 Mbps @8.192 Mbps @16.384 Mbps	t _{SOD2} t _{SOD4} t _{SOD8} t _{SOD16}	0 0 0 0		6 6 6	ns ns ns ns	Multiplied Clock Mode
	@2.048 Mbps @4.096 Mbps @8.192 Mbps @16.384 Mbps	t _{SOD2} t _{SOD4} t _{SOD8} t _{SOD16}	-6 -6 -6 -6		0 0 0	ns ns ns ns	Divided Clock Mode

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

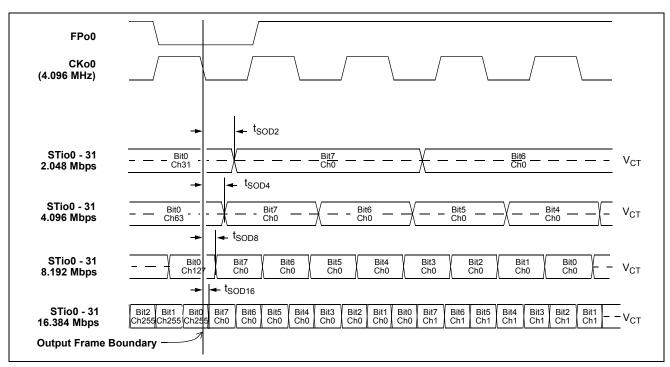


Figure 31 - ST-BUS Output Timing Diagram when Operated at 2, 4, 8 or 16 Mbps

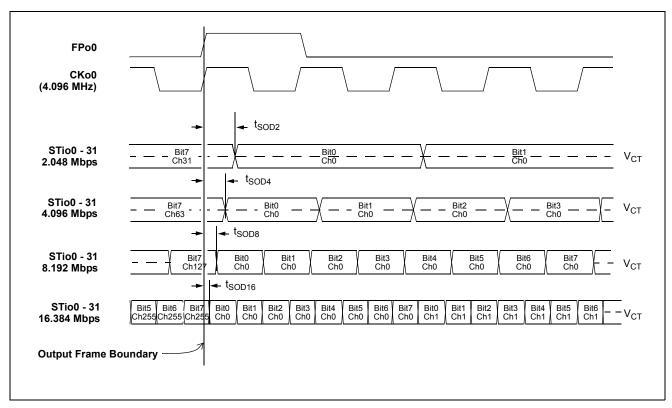


Figure 32 - GCI-Bus Output Timing Diagram when Operated at 2, 4, 8 or 16 Mbps

AC Electrical Characteristics[†] - ST-BUS/GCI-Bus Output Tristate Timing

	Characteristic	Sym.	Min.	Typ. [‡]	Max.	Units	Test Conditions [*]
1	STio Delay - Active to High-Z	t _{DZ}	-3 -8		7 0	ns ns	Multiplied Clock Mode Divided Clock Mode
2	STio Delay - High-Z to Active	t _{ZD}	-3 -8		7 0	ns ns	Multiplied Clock Mode Divided Clock Mode
3	Output Drive Enable (ODE) Delay - High-Z to Active	t _{ZD_ODE}			77	ns	Multiplied Clock Mode
	CKi @ 4.096 MHz CKi @ 8.192 MHz CKi @ 16.384 MHz				260 138 77	ns ns ns	Divided Clock Mode

[†] Characteristics are over recommended operating conditions unless otherwise stated.

Note 1: High impedance is measured by pulling to the appropriate rail with R_L , with timing corrected to cancel the time taken to discharge C_L .

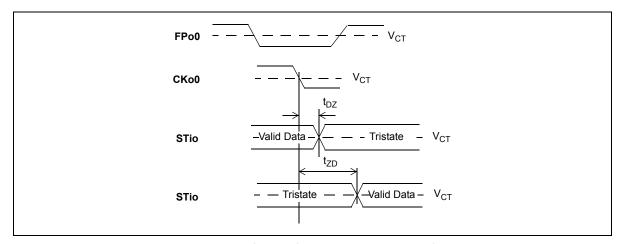


Figure 33 - Serial Output and External Control

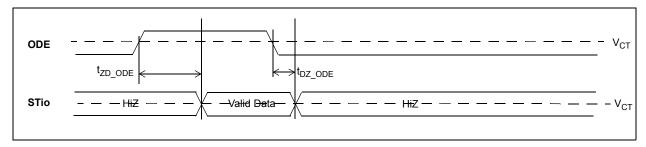


Figure 34 - Output Drive Enable (ODE)

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics[†] - Clock Mode Input/Output Frame Boundary Alignment

	Characteristic	Sym.	Min.	Typ. [‡]	Max.	Units	Notes
1	Input and Output Frame Offset in Divided Clock Mode	t _{FBOS}	5		13	ns	
2	Input and Output Frame Offset in Multiplied Clock Mode	^t FBOS	2		10	ns	Input reference jitter is equal to zero.

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

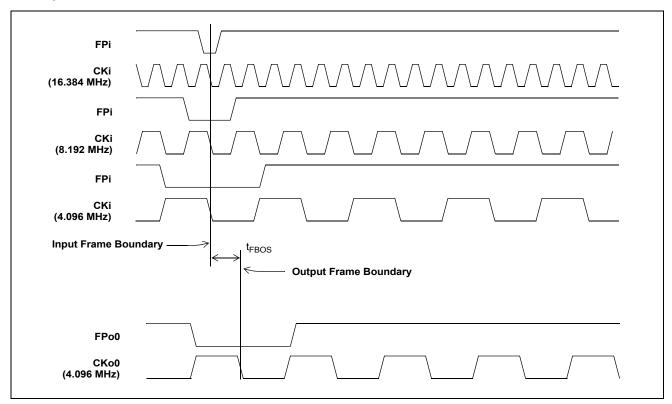


Figure 35 - Input and Output Frame Boundary Offset

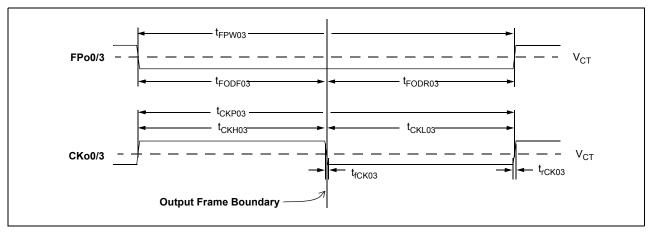


Figure 36 - FPo0 and CKo0 Timing Diagram

AC Electrical Characteristics[†] - FPo0/CKo0 and FPo3/CKo3 (4.096 MHz) Timing for Divided Clock Mode and Multiplied Clock Mode with Less than 10 ns of Input Cycle to Cycle Variation

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo0 Output Pulse Width	t _{FPW03}	239	244	249	ns	
2	FPo0 Output Delay from the FPo0 falling edge to the output frame boundary	t _{FODF03}	117		127	ns	C _L = 30 pF
3	FPo0 Output Delay from the output frame boundary to the FPo0 rising edge	t _{FODR03}	117		127	ns	
4	CKo0 Output Clock Period	t _{CKP03}	239	244	249	ns	
5	CKo0 Output High Time	t _{CKH03}	117		127	ns	$C_L = 30 pF$
6	CKo0 Output Low Time	t _{CKL03}	117		127	ns	
7	CKo0 Output Rise/Fall Time	t _{rCK03} , t _{fCK03}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - FPo0/CKo0 and FPo3/CKo3 (4.096 MHz) Timing for Multiplied Clock Mode with More than 10 ns of Cycle to Cycle Variation on CKi

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo0 Output Pulse Width	t _{FPW03}	218	244	270	ns	
2	FPo0 Output Delay from the FPo0 falling edge to the output frame boundary	t _{FODF03}	117		127	ns	C _L = 30 pF
3	FPo0 Output Delay from the output frame boundary to the FPo0 rising edge	t _{FODR03}	97		146	ns	
4	CKo0 Output Clock Period	t _{CKP03}	218	244	270	ns	
5	CKo0 Output High Time	t _{CKH03}	117		127	ns	$C_L = 30 pF$
6	CKo0 Output Low Time	t _{CKL03}	97		146	ns	
7	CKo0 Output Rise/Fall Time	t_{rCK03},t_{fCK03}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

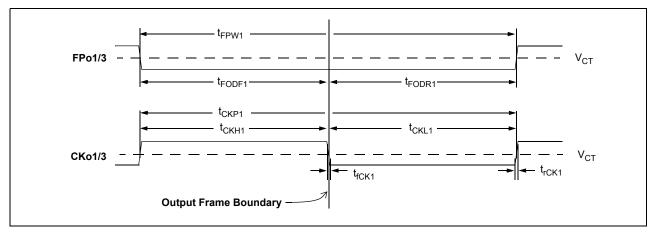


Figure 37 - FPo1 and CKo1 Timing Diagram

AC Electrical Characteristics[†] - FPo1/CKo1 and FPo3/CKo3 (8.192 MHz) Timing for Divided Clock Mode and Multiplied Clock Mode with Less than 10 ns of Input Cycle to Cycle Variation

	Characteristic	Sym.	Min.	Typ. [‡]	Max.	Units	Notes
1	FPo1 Output Pulse Width	t _{FPW13}	117	122	127	ns	
2	FPo1 Output Delay from the FPo1 falling edge to the output frame boundary	t _{FODF13}	56		66	ns	C _L = 30 pF
3	FPo1 Output Delay from the output frame boundary to the FPo1 rising edge	t _{FODR13}	56		66	ns	
4	CKo1 Output Clock Period	t _{CKP13}	117	122	127	ns	
5	CKo1 Output High Time	t _{CKH13}	56		66	ns	$C_L = 30 pF$
6	CKo1 Output Low Time	t _{CKL13}	56		66	ns	
7	CKo1 Output Rise/Fall Time	t _{rCK13} , t _{fCK13}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - FPo1/CKo1 and FPo3/CKo3 (8.192 MHz) Timing for Multiplied Clock Mode with More than 10 ns of Cycle to Cycle Variation on CKi

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo1 Output Pulse Width	t _{FPW13}	106	122	127	ns	
2	FPo1 Output Delay from the FPo1 falling edge to the output frame boundary	t _{FODF13}	56		66	ns	C _L = 30 pF
3	FPo1 Output Delay from the output frame boundary to the FPo1 rising edge	t _{FODR13}	46		66	ns	
4	CKo1 Output Clock Period	t _{CKP13}	106	122	148	ns	
5	CKo1 Output High Time	t _{CKH13}	46		87	ns	$C_L = 30 pF$
6	CKo1 Output Low Time	t _{CKL13}	46		66	ns	
7	CKo1 Output Rise/Fall Time	t _{rCK13} , t _{fCK13}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

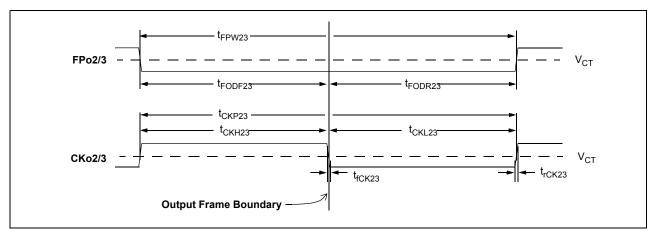


Figure 38 - FPo2 and CKo2 Timing Diagram

AC Electrical Characteristics[†] - FPo2/CKo2 and FPo3/CKo3 (16.384 MHz) Timing for Divided Clock Mode and Multiplied Clock Mode with Less than 10 ns of Cycle to Cycle Variation on CKİ

	Characteristic	Sym.	Min.	Typ. [‡]	Max.	Units	Notes
1	FPo2 Output Pulse Width	t _{FPW23}	56	61	66	ns	
2	FPo2 Output Delay from the FPo2 falling edge to the output frame boundary	t _{FODF23}	25		36	ns	C _L = 30 pF
3	FPo2 Output Delay from the output frame boundary to the FPo1 rising edge	t _{FODR23}	25		36	ns	
4	CKo2 Output Clock Period	t _{CKP23}	56	61	66	ns	
5	CKo2 Output High Time	t _{CKH23}	25		36	ns	$C_L = 30 pF$
6	CKo2 Output Low Time	t _{CKL23}	25		36	ns	
7	CKo2 Output Rise/Fall Time	t_{rCK23}, t_{fCK23}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - FPo2/CKo2 and FPo3/CKo3 (16.384 MHz) Timing for Multiplied Clock Mode with More than 10 ns of Cycle to Cycle Variation on CKi

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo2 Output Pulse Width	t _{FPW23}	56	61	66	ns	
2	FPo2 Output Delay from the FPo2 falling edge to the output frame boundary	t _{FODF23}	25		36	ns	C _L = 30 pF
3	FPo2 Output Delay from the output frame boundary to the FPo2 rising edge	t _{FODR23}	25		36	ns	
4	CKo2 Output Clock Period	t _{CKP2}	47	61	76	ns	
5	CKo2 Output High Time	t _{CKH23}	17		43	ns	$C_L = 30 pF$
6	CKo2 Output Low Time	t _{CKL23}	17		43	ns	
7	CKo2 Output Rise/Fall Time	t_{rCK23},t_{fCK23}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

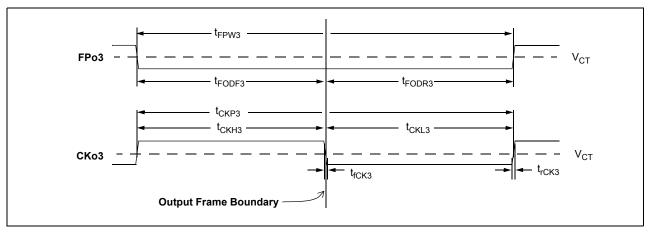


Figure 39 - FPo3 and CKo3 Timing Diagram

AC Electrical Characteristics[†] - FPo3/CKo3 (32.768 MHz) Timing for Divided Clock Mode and Multiplied Clock Mode with Less than 10 ns of Cycle to Cycle Variation on CKi

	Characteristic	Sym.	Min.	Typ.‡	Max.	Units	Notes
1	FPo3 Output Pulse Width	t _{FPW3}	27	30.5	34	ns	
2	FPo3 Output Delay from the FPo3 falling edge to the output frame boundary	t _{FODF3}	10		18	ns	C _L = 30 pF
3	FPo3 Output Delay from the output frame boundary to the FPo3 rising edge	t _{FODR3}	12		21	ns	
4	CKo3 Output Clock Period	t _{CKP3}	27	30.5	34	ns	
5	CKo3 Output High Time	t _{CKH3}	12		19	ns	$C_L = 30 pF$
6	CKo3 Output Low Time	t _{CKL3}	12		19	ns	
7	CKo3 Output Rise/Fall Time	t _{rCK3} , t _{fCK3}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - FPo3/CKo3 (32.768 MHz) Timing for Multiplied Clock Mode with More than 10 ns of Cycle to Cycle Variation on CKi

	Characteristic	Sym.	Min.	Typ. [‡]	Max.	Units	Notes
1	FPo3 Output Pulse Width	t _{FPW3}	27	30.5	34	ns	
2	FPo3 Output Delay from the FPo3 falling edge to the output frame boundary	t _{FODF3}	12		19	ns	C _L = 30 pF
3	FPo3 Output Delay from the output frame boundary to the FPo3 rising edge	t _{FODR3}	12		19	ns	
4	CKo3 Output Clock Period	t _{CKP3}	17	30.5	44	ns	
5	CKo3 Output High Time	t _{CKH3}	5		29	ns	$C_L = 30 pF$
6	CKo3 Output Low Time	t _{CKL3}	12		18	ns	
7	CKo3 Output Rise/Fall Time	t _{rCK3} , t _{fCK3}			5	ns	

[†] Characteristics are over recommended operating conditions unless otherwise stated.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

[‡] Typical figures are at 25°C, VDD_CORE at 1.8 V and VDD_IO at 3.3 V and are for design aid only: not guaranteed and not subject to production testing.

AC Electrical Characteristics † - Divided Clock Mode Output Timing

	Characteristic	Sym.	Min.	Max.	Units
1	CKo0 to CKo1 (8.192 MHz) delay	t _{C1D}	-1	2	ns
2	CKo0 to CKo2 (16.384 MHz) delay	t _{C2D}	-1	3	ns
3	CKo0 to CKo3 (16.384 MHz/8.192 MHz/4.096 MHz) delay	t _{C3D}	-2	2	ns

[†] Characteristics are over recommended operating conditions unless otherwise stated.

AC Electrical Characteristics[†] - Multiplied Clock Mode Output Timing

	Characteristic	Sym.	Min.	Max.	Units
1	CKo0 to CKo1 (8.192 MHz) delay	t _{C1D}	-1	2	ns
2	CKo0 to CKo2 (16.384 MHz) delay	t _{C2D}	-1	3	ns
3	CKo0 to CKo3 (32.768 MHz/16.384 MHz/8.192 MHz/4.096 MHz) delay	t _{C3D}	-1	3	ns

[†] Characteristics are over recommended operating conditions unless otherwise stated.

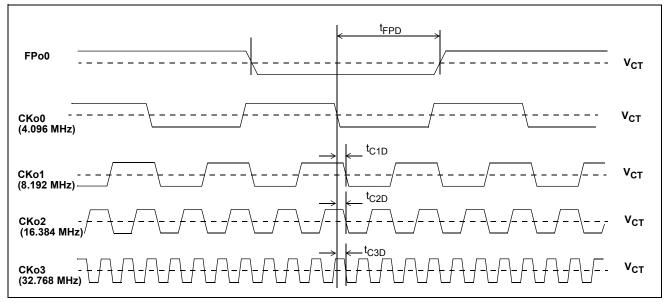
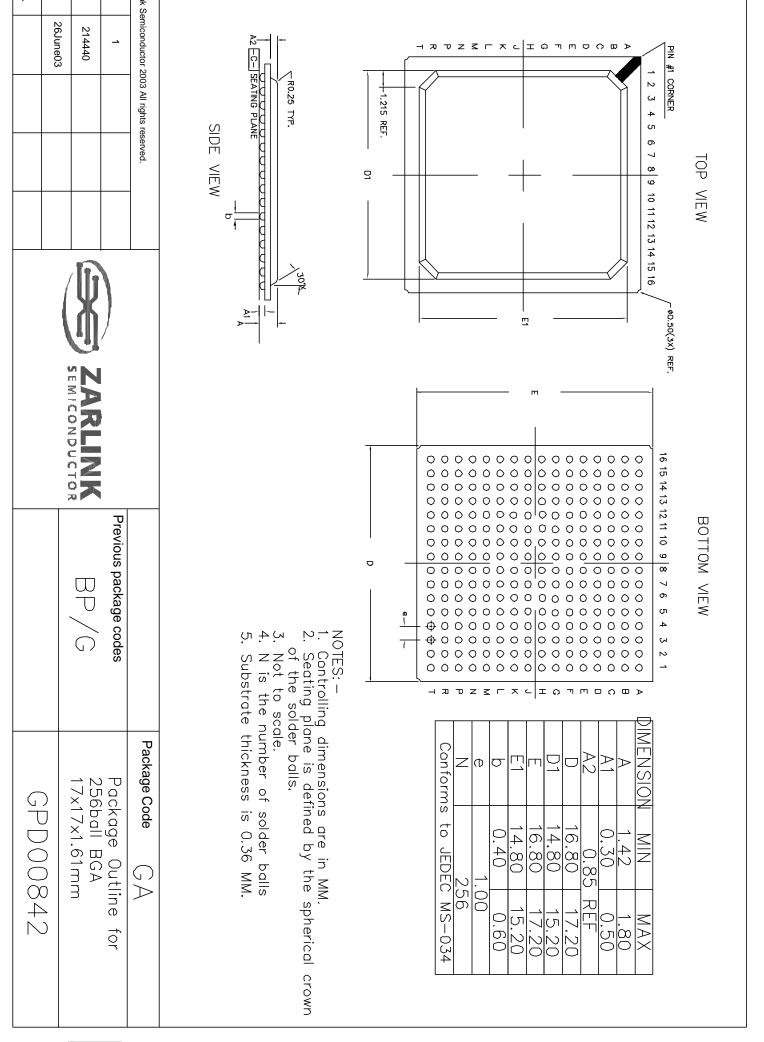
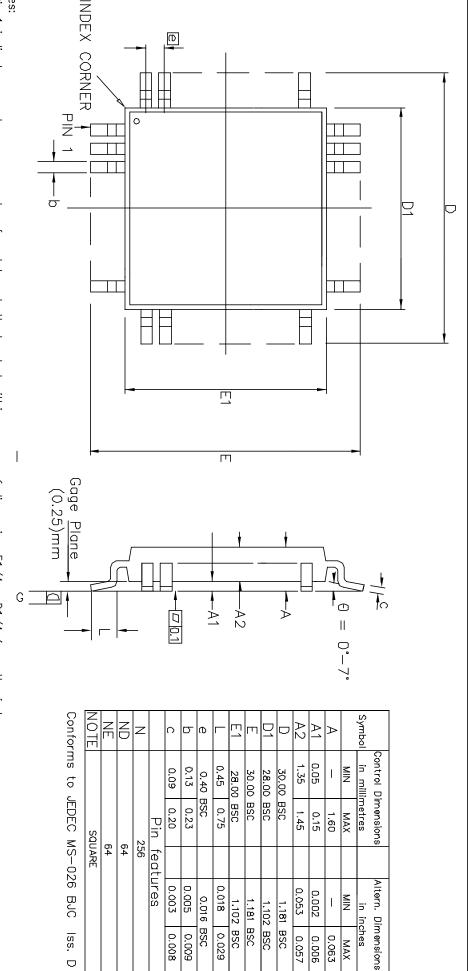


Figure 40 - Output Timing (ST-BUS Format)





0.029

0.008

0.009

0.057

0.006 0,063 MAX

lss. O

II dimensioning and tolerancing conform to ANSI Y14.5—1982. in 1 indicator may be a corner chamfer, dot or both, located within a zone of dimension E1/4 imes D1/4 from the index corner

)imensions D1 and E1 do nat include mald protrusion — allowable mold protrusion is 0.254 mm on D1 and E1 dimensions.

N" is the total number of terminals

limension b does not include Dambar protrusion. ackage top dimensions are smaller than bottom dimensions and top of package will not overhang bottom of package

Controlling Dimensions are in Millimeter

k Semiconductor 2003 All rights reserved.			Package Code ()(
1 2 3 4		Previous package codes	Package Outline for 256 lead
214172 214382	ZARLINK ZARLINK	GP	LQFP (28 x 28 x 1.4mm) $\frac{1}{2}$ 0mm Footprint
27Mar03 12June03			
•			GPD00837

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